

Compal Confidential

LA-7461 Schematics Document

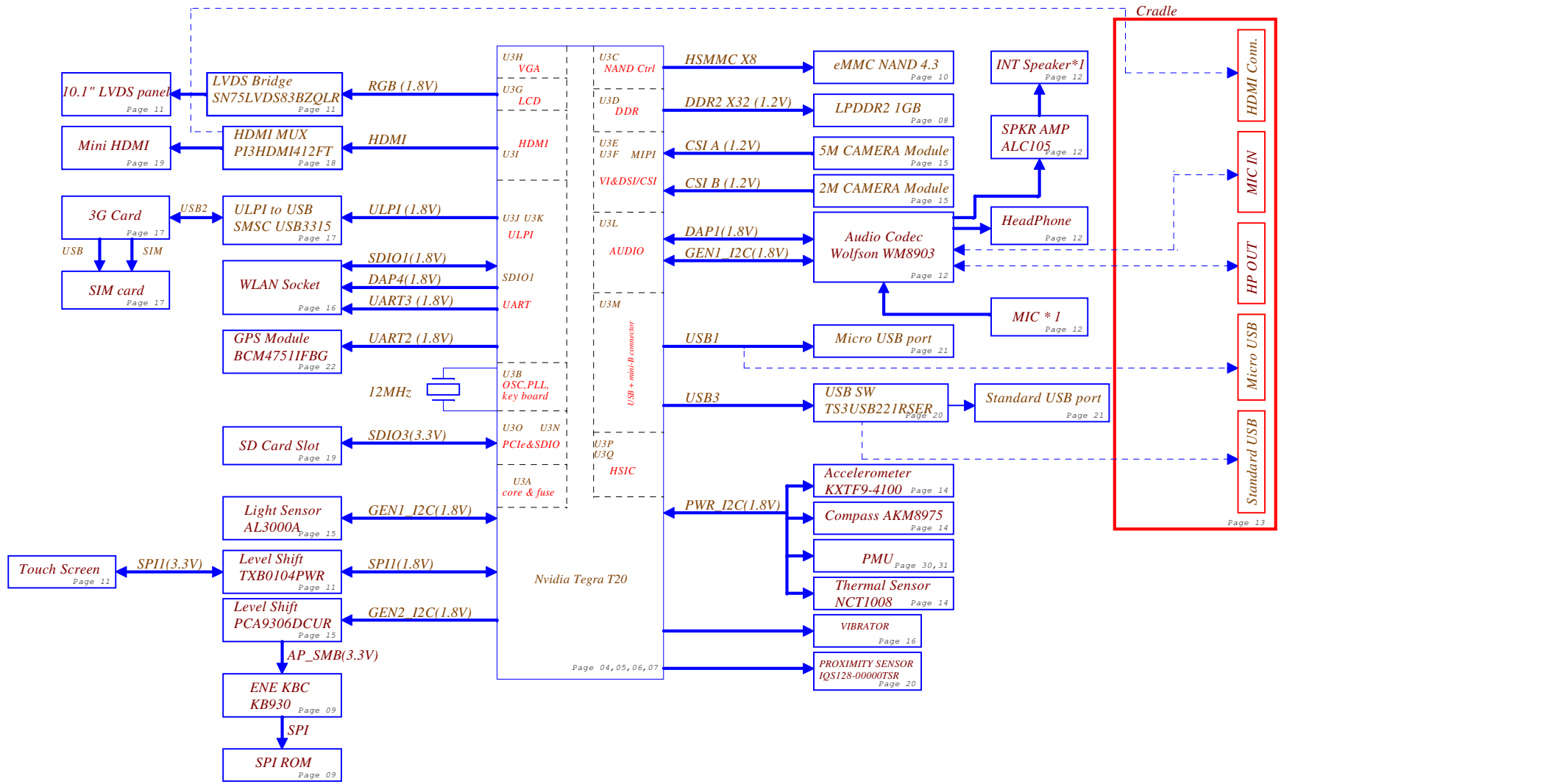
Nvidia(T20) + LPDDRII

2011-04-22

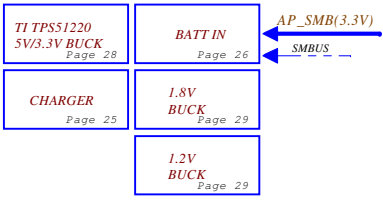
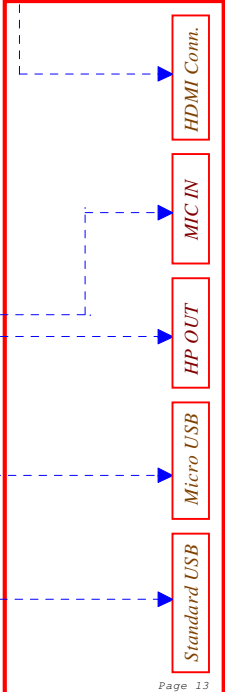
REV: 0.3

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HDMI to Cradle



Cradle



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Voltage Rails

Power Plane	Description
VIN	Power supply (19V)
B+	AC or battery power rail for power circuit.
+1.2VS_SM0	Core voltage for CPU
+1.0VS_SM1	CPU voltage for CPU
+1.1VS_LDO1	AVDD_PLL power rail
+1.2VS_LDO2	T20 RTC power rail
+1.8VS_LDO4	T20 system power rail
+3.3VS_LDO3	T20 USB power rail
+2.85VS_LDO5	Core voltage for EMMC
+2.85VS_LDO6	Core voltage for CAMERA
+3.3VS_LDO7	T20 HDMI power rail
+1.8VS_LDO8	T20 HDMI PLL power rail
+2.85VS_LDO9	T20 DDR RX power rail
+3VALW	3.3V always on power rail
+3VS	3.3V switched power rail for standby mode
+5VALW	5V always on power rail
+1.8VS	1.8V always on power rail
+1.8VS_S3	1.8V switched power rail for standby mode
+3.3VS_RTC	RTC power

LPDDR2

NAND_D5	NAND_D4	SMT		LPDDR2		Part Number
L	L	R38	R39	ELPIDA	1G	SA000048Q30
L	H	R23	R39	Hynix	1G	SA00004MJ10
H	L	R38	R24	Samsung	1G	NA
H	H	R23	R24	NA		NA

PWR_I2C address

Device	Address
<input type="radio"/> FMU	0110 100x b
<input type="radio"/> E-Compass	0000 110x b
<input type="radio"/> Temperature sensor	0100 110x b

CAM_I2C address

Device	Address
<input type="radio"/> CAMERA 5M	
<input type="radio"/> CAMERA 2M	

GEN1_I2C

Device	Address
<input type="radio"/> Audio Codec	0011 010x b
<input type="radio"/> Light sensor	0001 110x b

TS_I2C

Device	Address
<input type="radio"/>	

GEN2_I2C

Device	Address
<input type="radio"/>	

AP_SMB

Device	Address
<input type="radio"/> LCD	
<input type="radio"/> 3G CARD	

EC_SMB

Device	Address
<input type="radio"/> BATT	0001 001x b

IME_I2C

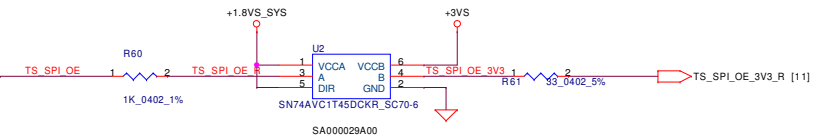
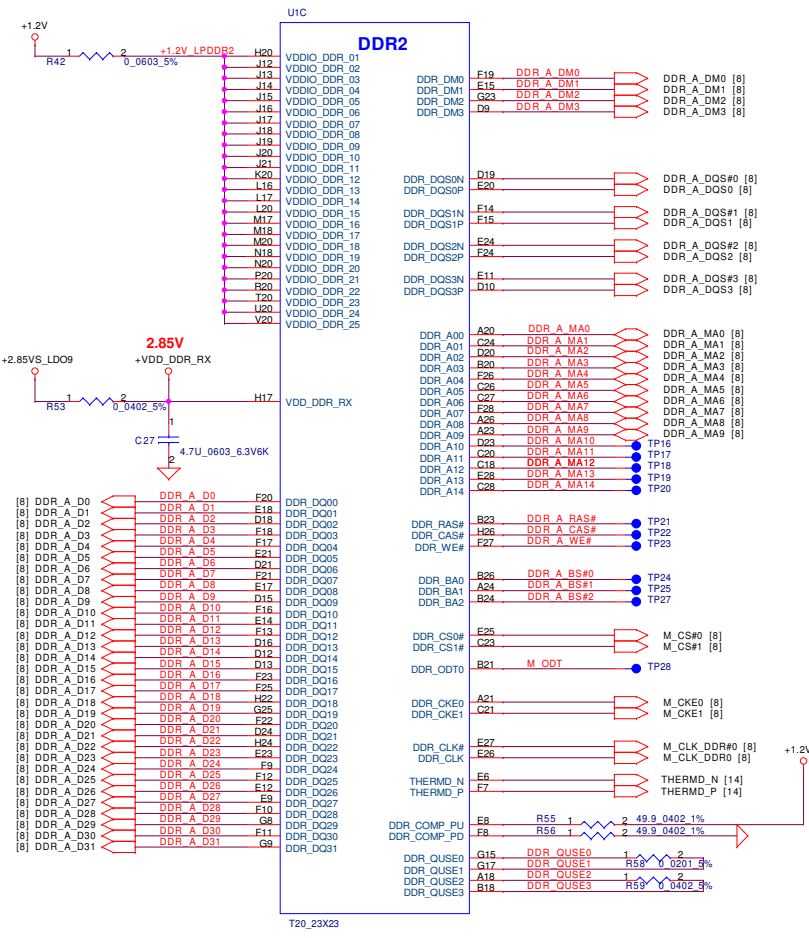
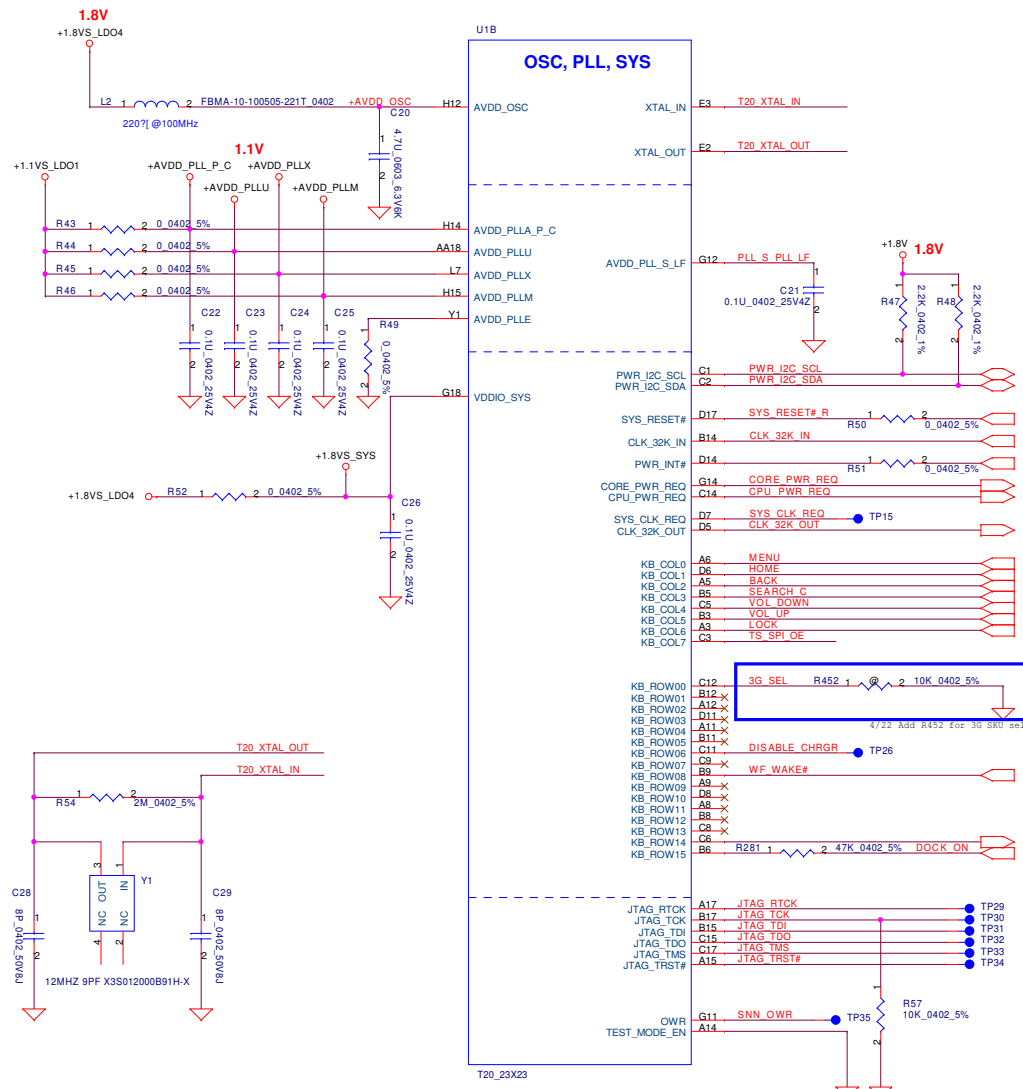
Device	Address
<input type="radio"/> G-sensor	0001 1111 b

DDC_I2C

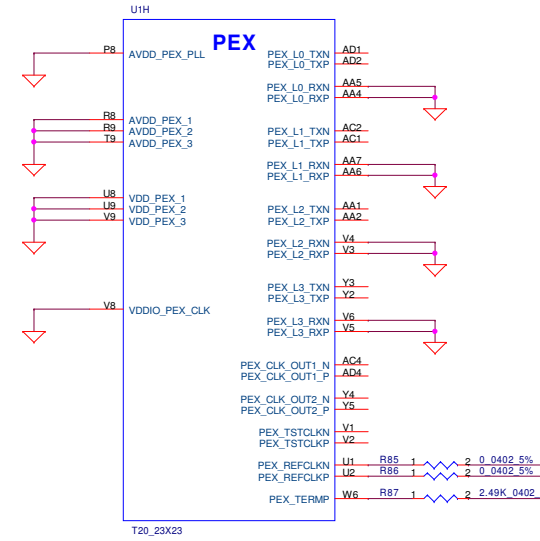
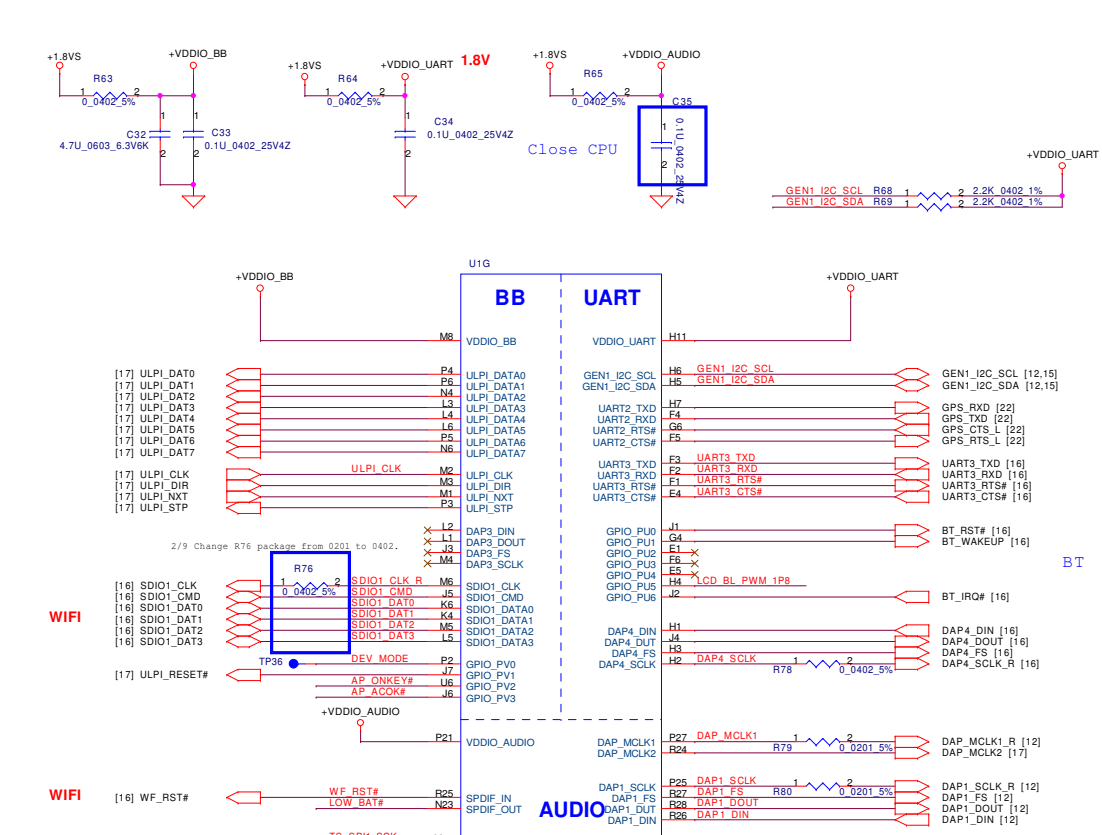
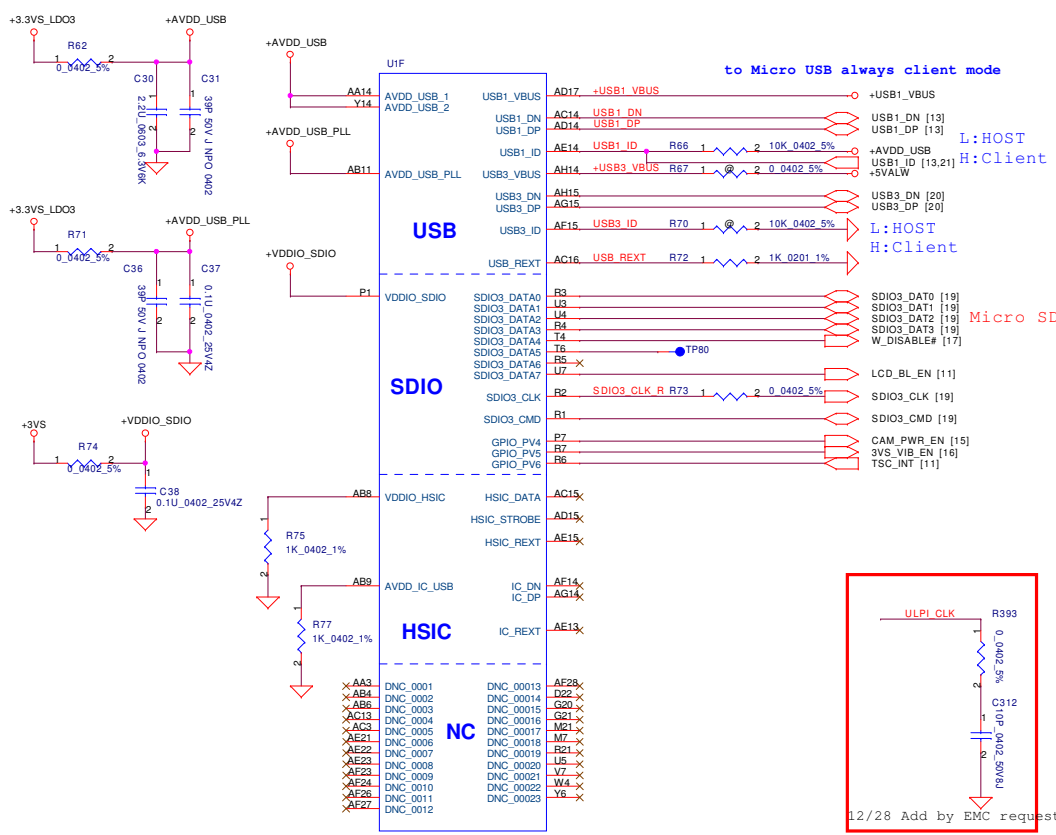
Device	Address
<input type="radio"/> HDM EDID	

HDMI_DDC_I2C

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				Size Custom	Document Number LA-7461P
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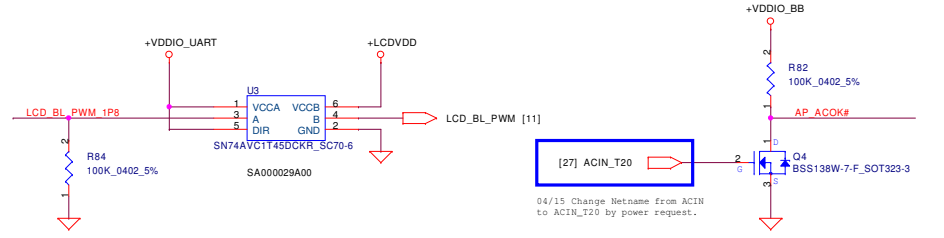
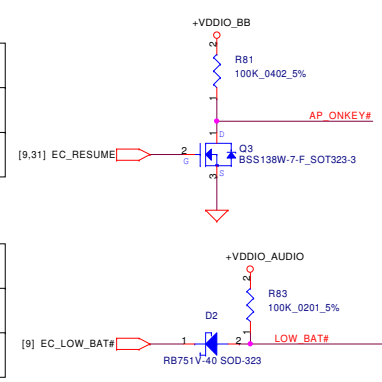


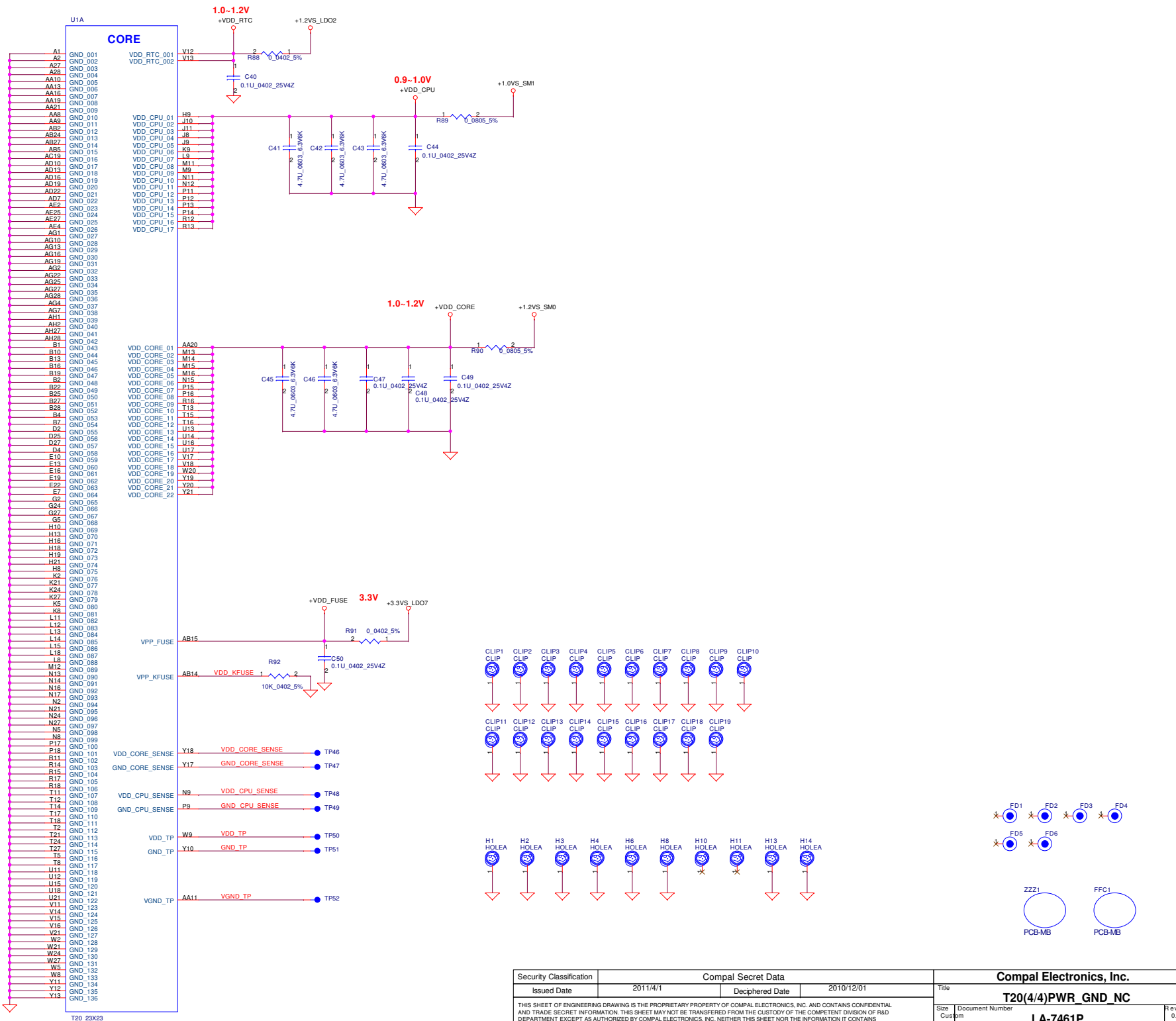
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				T20(2/4)OSC/PLL/SYS/DDR	
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Name	Active
EC_RESUMUE	High
AP_ONKEY#	Low

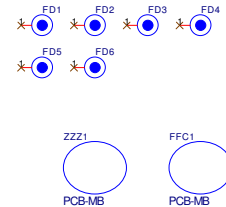
Name	Active
EC_LOW_BAT#	Low
LOW_BAT#	Low

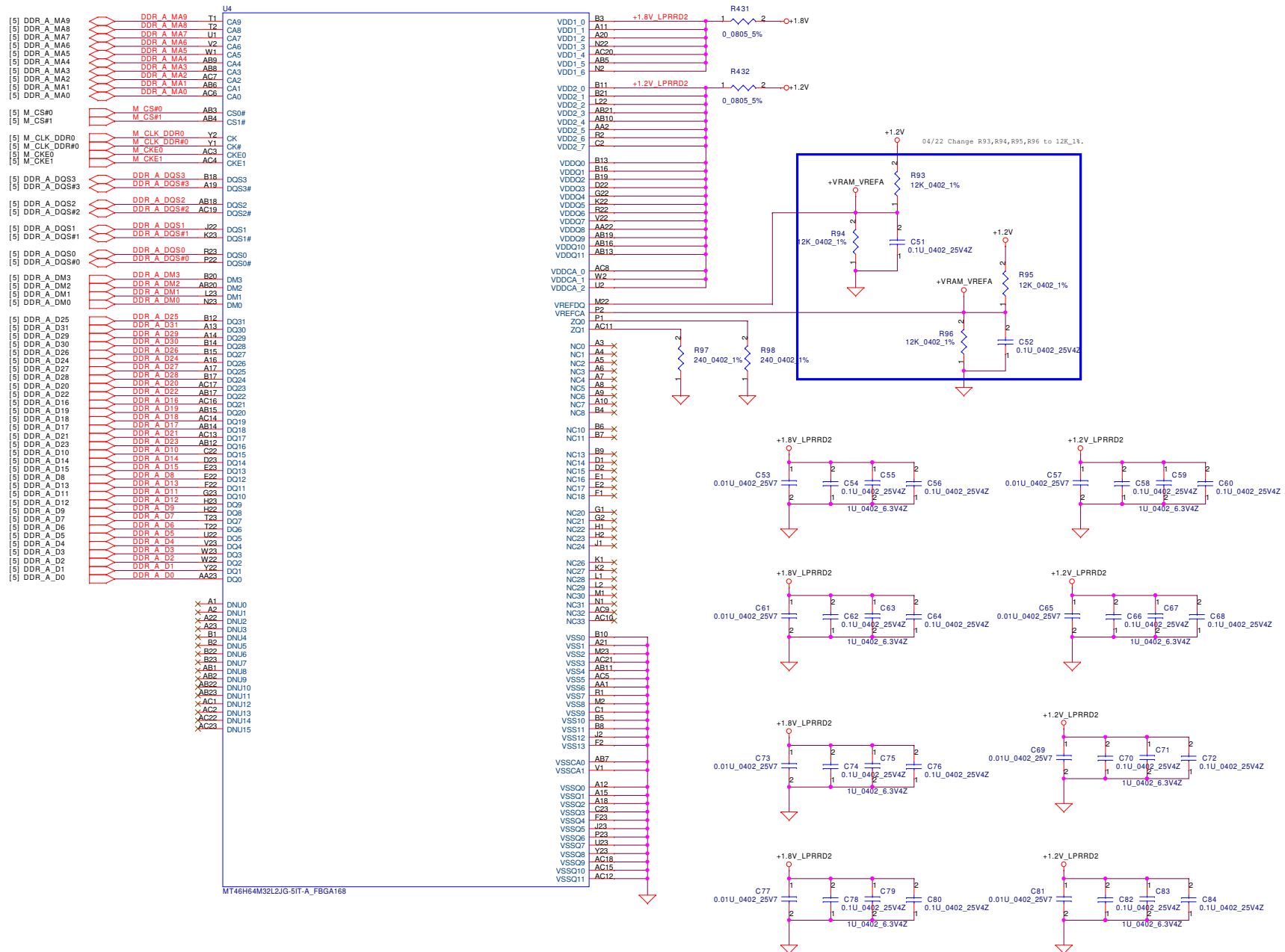




Pin	Function
A1	GND_001
A2	GND_002
A26	GND_003
AA10	GND_004
AA13	GND_005
AA16	GND_006
AA19	GND_007
AA21	GND_008
AA8	GND_009
AA9	GND_010
AB2	GND_011
AB24	GND_012
AB27	GND_013
AB5	GND_014
AD13	GND_015
AD19	GND_016
AD22	GND_017
AD7	GND_018
AE2	GND_019
AE25	GND_020
AE27	GND_021
AE4	GND_022
AG1	GND_023
AG10	GND_024
AG13	GND_025
AG16	GND_026
AG19	GND_027
AG2	GND_028
AG22	GND_029
AG25	GND_030
AG27	GND_031
AG33	GND_032
AG4	GND_033
AG7	GND_034
AH1	GND_035
AH2	GND_036
AH27	GND_037
AH29	GND_038
B1	GND_039
B10	GND_040
B13	GND_041
B16	GND_042
B19	GND_043
B2	GND_044
B22	GND_045
B25	GND_046
B27	GND_047
B28	GND_048
B4	GND_049
B7	GND_050
D2	GND_051
D25	GND_052
D27	GND_053
D4	GND_054
E13	GND_055
E16	GND_056
E19	GND_057
E22	GND_058
E7	GND_059
G2	GND_060
G24	GND_061
G27	GND_062
G6	GND_063
H10	GND_064
H13	GND_065
H16	GND_066
H18	GND_067
H19	GND_068
H21	GND_069
H8	GND_070
K2	GND_071
K21	GND_072
K24	GND_073
K27	GND_074
K6	GND_075
K8	GND_076
L11	GND_077
L12	GND_078
L13	GND_079
L14	GND_080
L15	GND_081
L18	GND_082
L8	GND_083
M12	GND_084
N13	GND_085
N14	GND_086
N16	GND_087
N17	GND_088
N2	GND_089
N21	GND_090
N24	GND_091
N27	GND_092
N6	GND_093
N8	GND_094
N8	GND_095
P17	GND_096
P18	GND_097
R11	GND_098
R14	GND_099
R15	GND_100
R17	GND_101
R18	GND_102
T11	GND_103
T12	GND_104
T14	GND_105
T17	GND_106
T19	GND_107
T2	GND_108
T21	GND_109
T24	GND_110
T27	GND_111
T6	GND_112
T8	GND_113
U11	GND_114
U12	GND_115
U15	GND_116
U18	GND_117
U21	GND_118
V11	GND_119
V14	GND_120
V15	GND_121
V16	GND_122
V21	GND_123
W2	GND_124
W21	GND_125
W24	GND_126
W27	GND_127
W5	GND_128
W8	GND_129
Y11	GND_130
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Y13	GND_133
Y13	GND_134
Y13	GND_135
Y13	GND_136

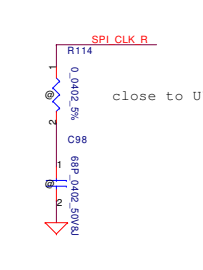
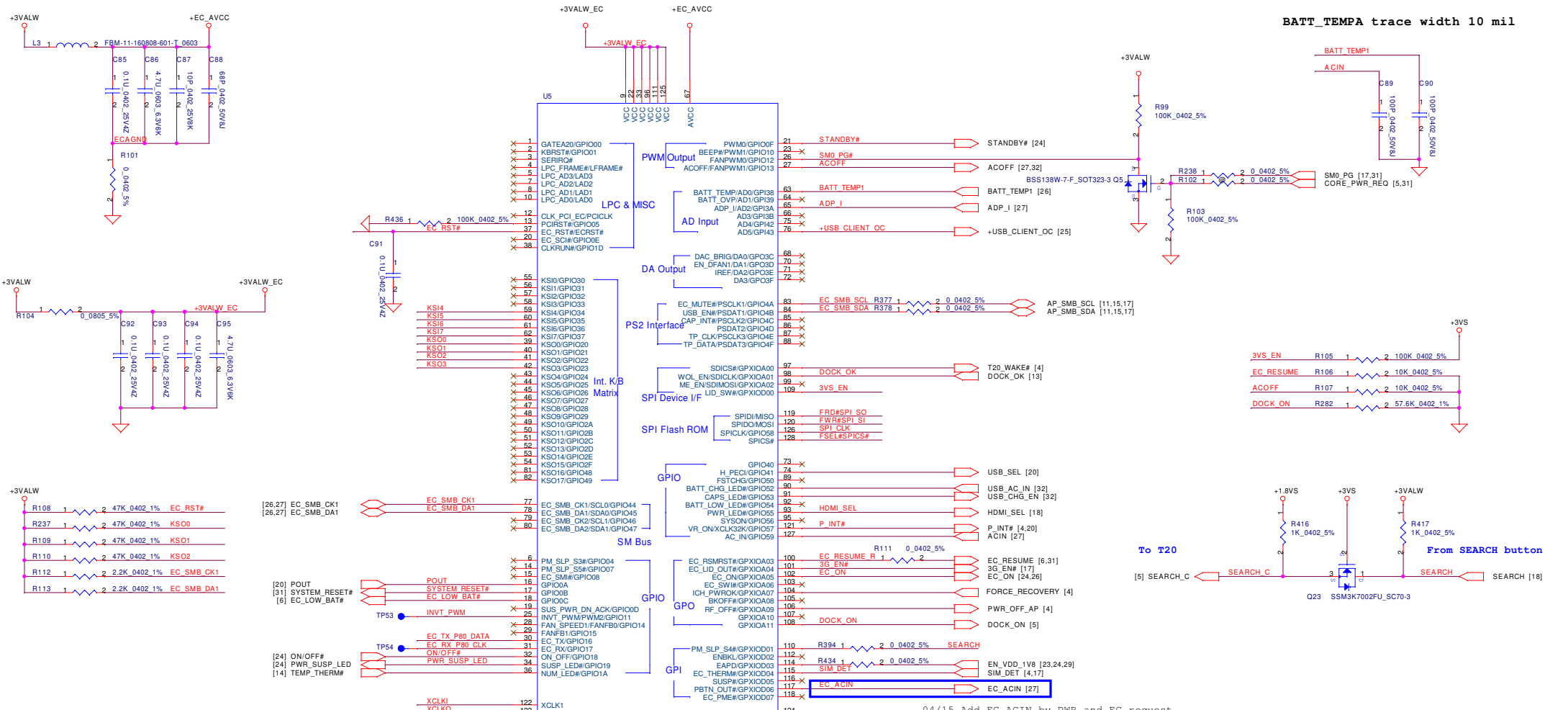
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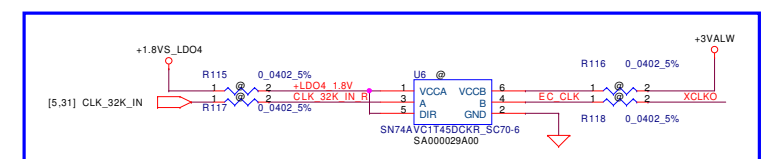
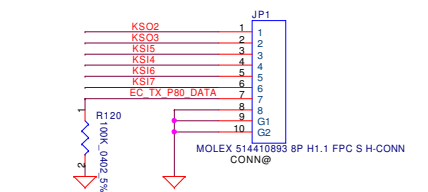
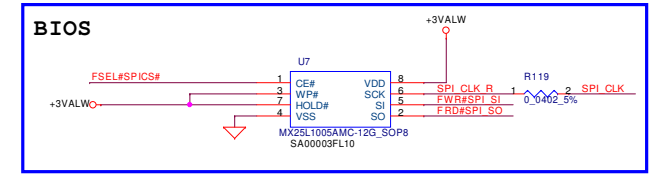


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				DDRII-DEVICE DOWN(1/2)	
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BATT_TEMP trace width 10 mil



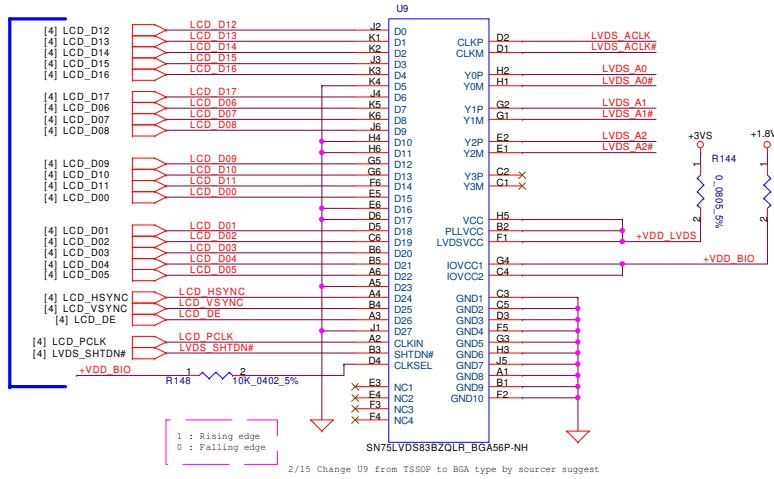
3/28 Change C99 and C100 to 33pF to reduce X1 output CLK deviation



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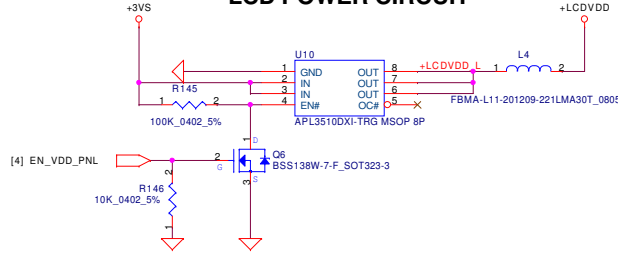
LVDS Bridge

1.8V level

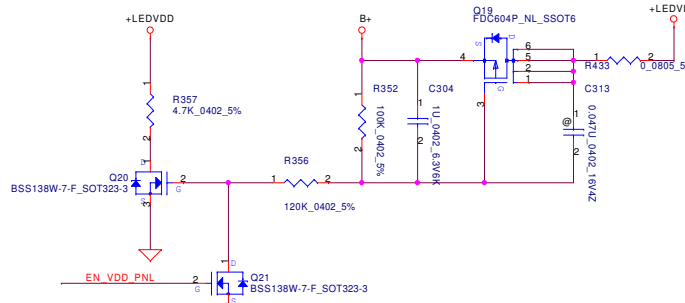


LVDS

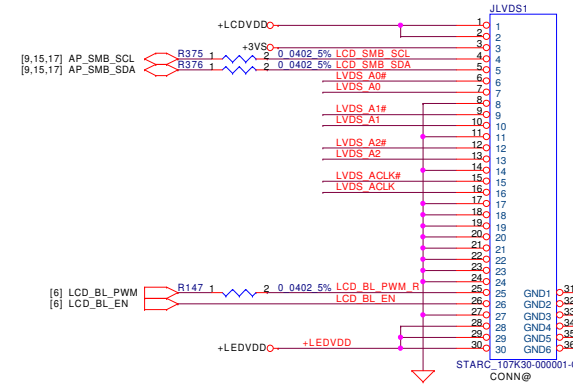
LCD POWER CIRCUIT



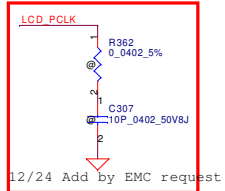
LED POWER CIRCUIT



LVDS CONN



Close U9

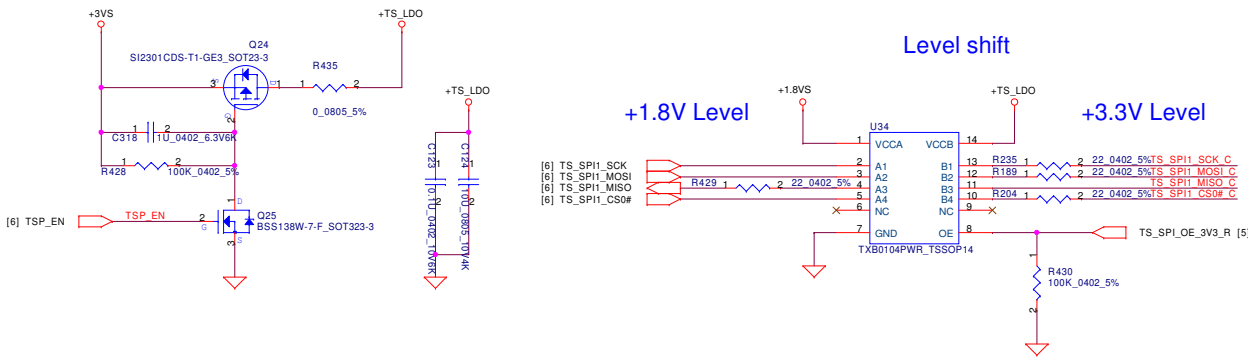


TOUCH SCREEN

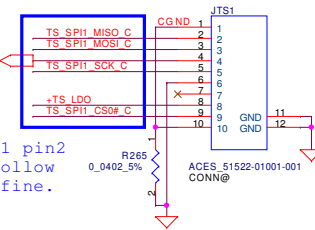
Level shift

+1.8V Level

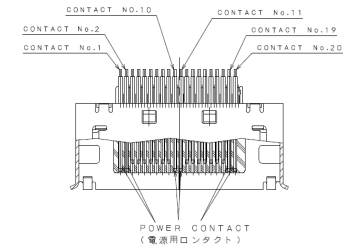
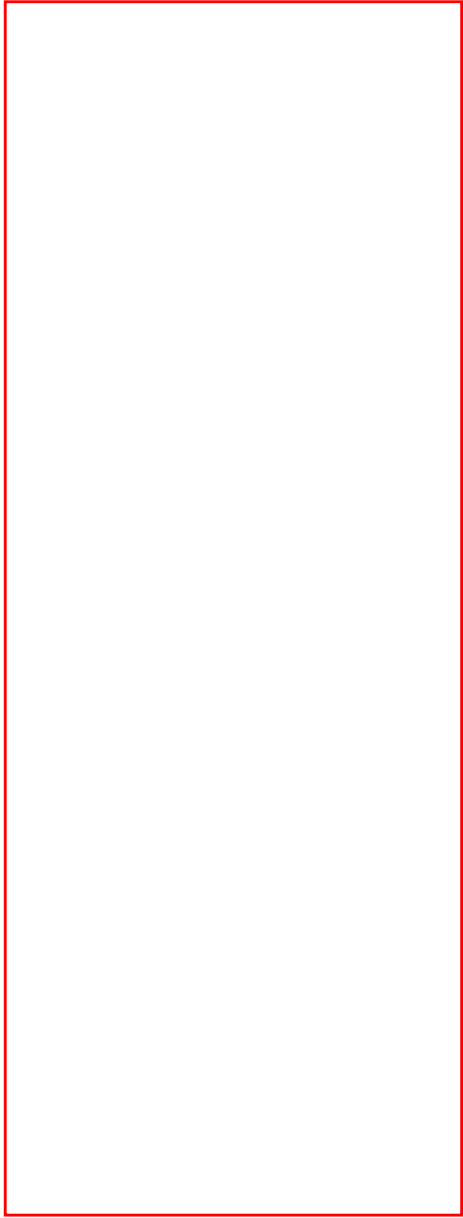
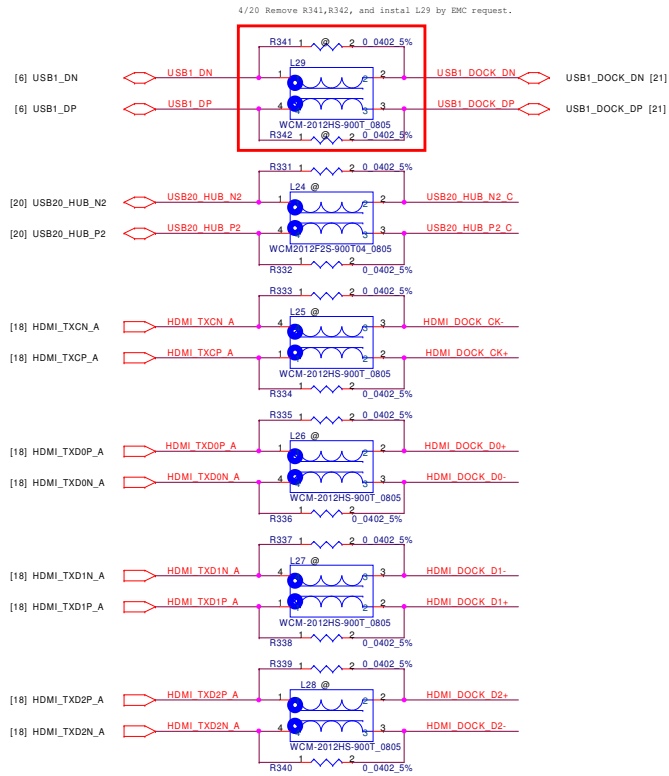
+3.3V Level



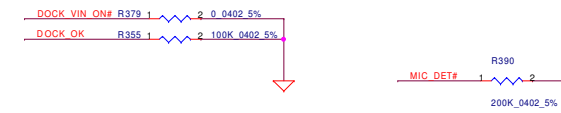
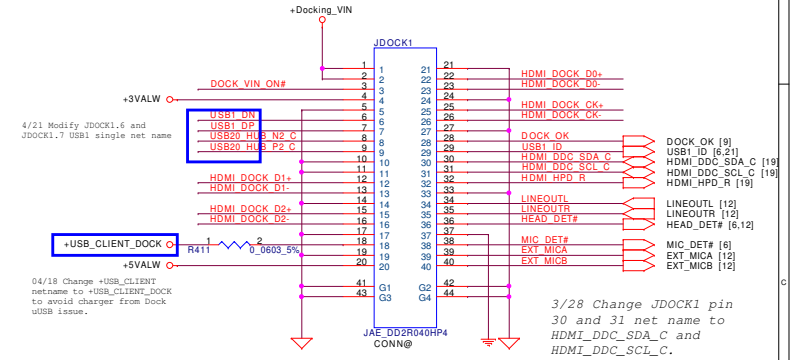
3/22 Swap JTS1 pin2 and pin3 to follow module pin define.



Pin #	SPI interface (Compal XPAD) Host side 10 pins- Proposed
1	CGND
2	MISO
3	MOSI
4	INT#
5	SCK
6	GND
7	N.C
8	LDO (Low Dropout Regulator) +3.3 Vcc
9	CS0#
10	SS L, Slave Select (active low)



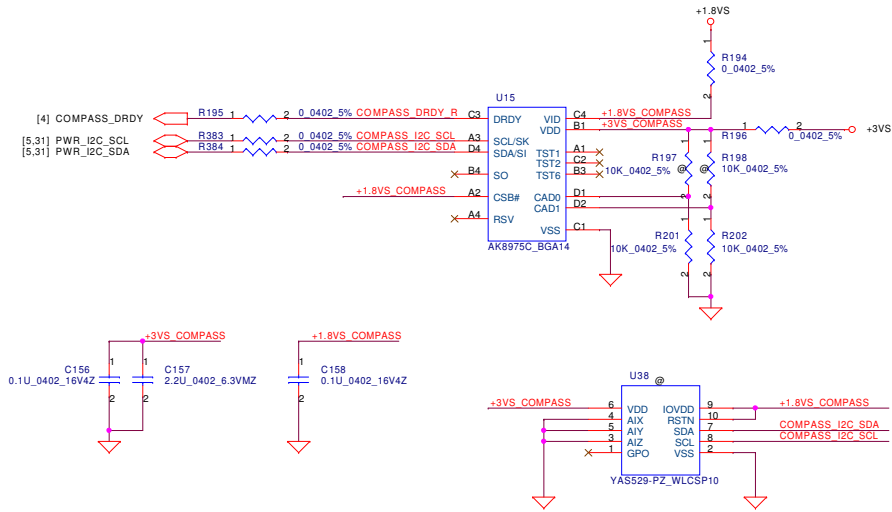
- Docking Function
1. HDMI
 2. Standard USB
 3. Micro USB
 4. HP out
 5. MIC IN
 6. AC IN



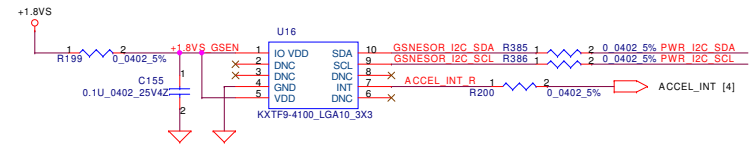
- 12/23 Add for EMC request
 12/29 Change ESD diode package
 04/21 Remove ESD diode D6,D19,D20,D21,D22,D25,D31 by EMC request.

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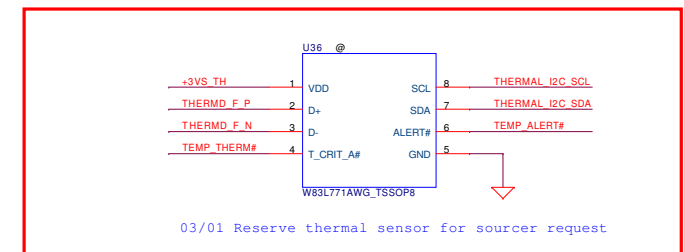
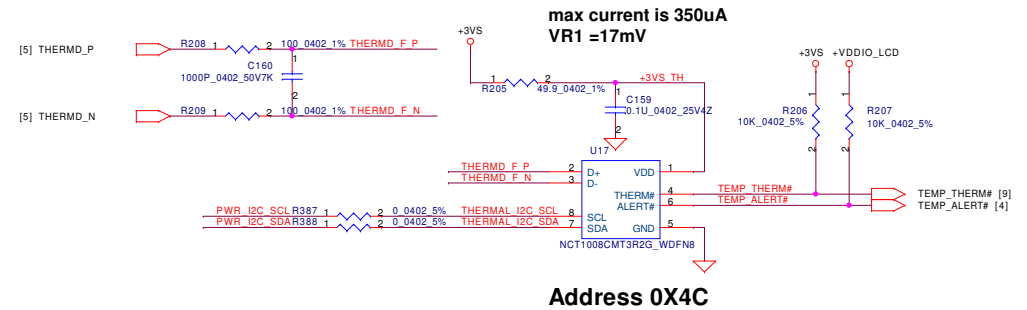
ECompass



G-SENSOR

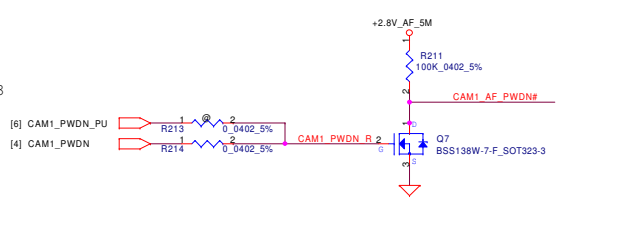
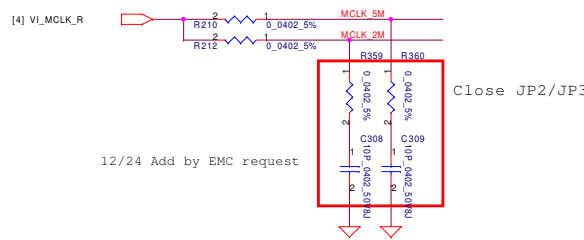
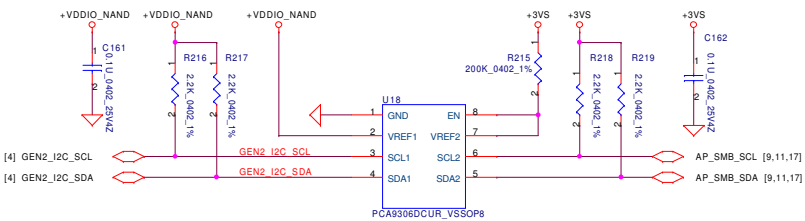


THERMAL

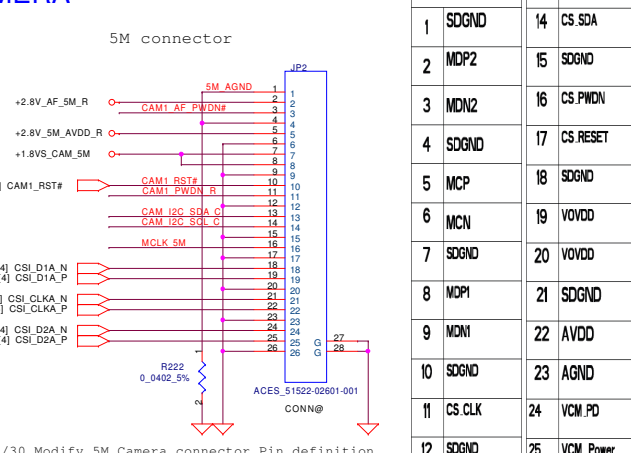
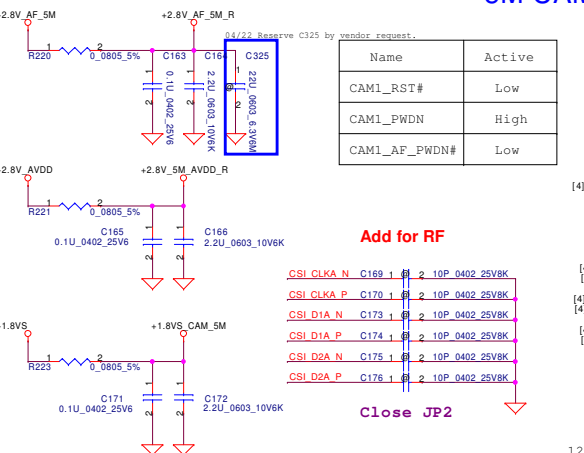
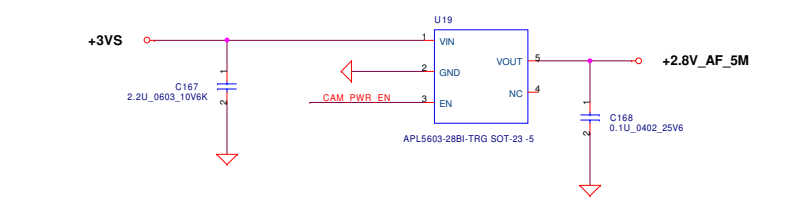


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Level shift

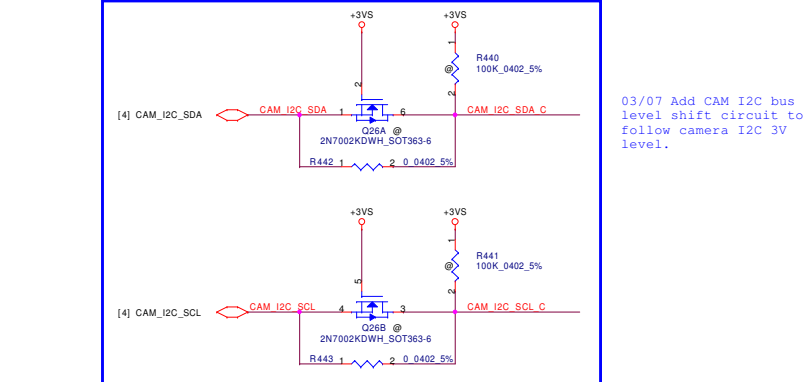
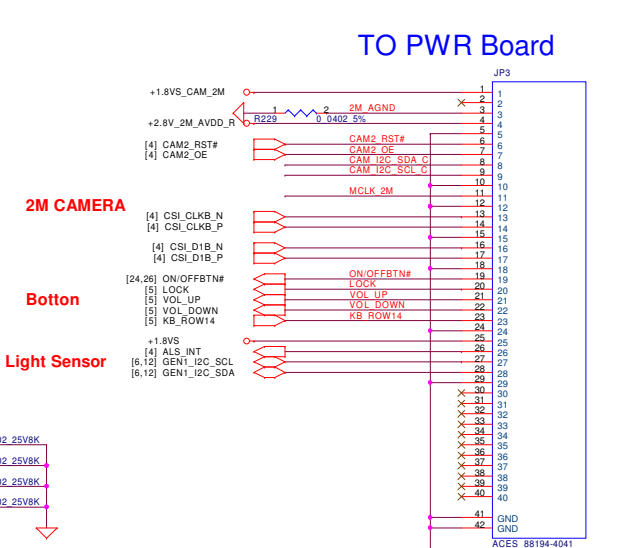
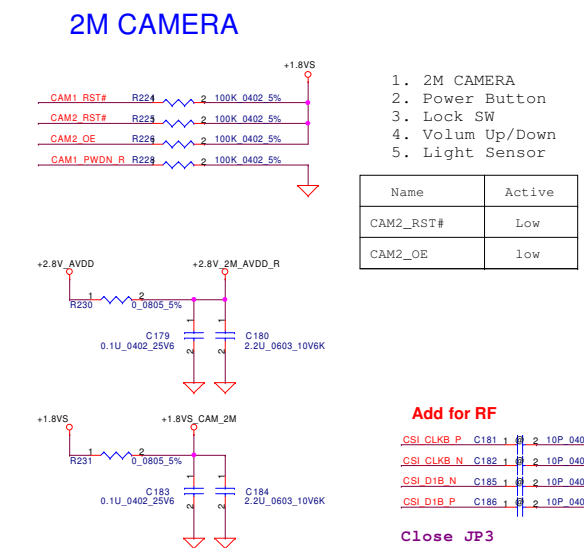
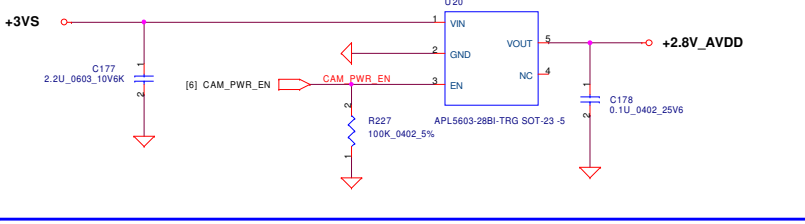


5M CAMERA LDO



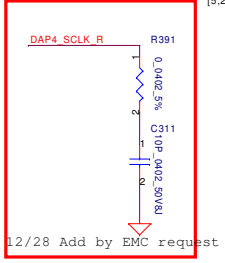
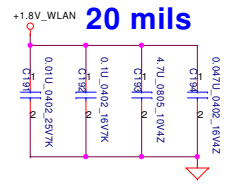
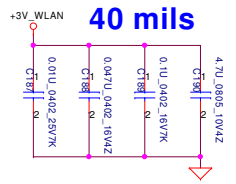
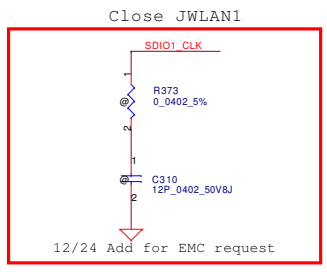
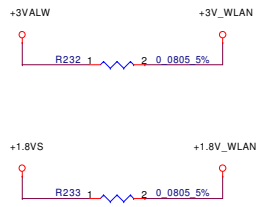
CN Table		
1	SDGND	14 CS_SDA
2	MDP2	15 SDGND
3	MDN2	16 CS_PWDN
4	SDGND	17 CS_RESET
5	MCP	18 SDGND
6	MCN	19 VOVDD
7	SDGND	20 VOVDD
8	MDP1	21 SDGND
9	MDN1	22 AVDD
10	SDGND	23 AGND
11	CS_CLK	24 VCM_PD
12	SDGND	25 VCM Power
13	CS_SCK	26 VCMGND

2M CAMERA LDO

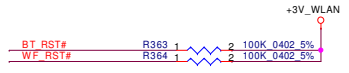
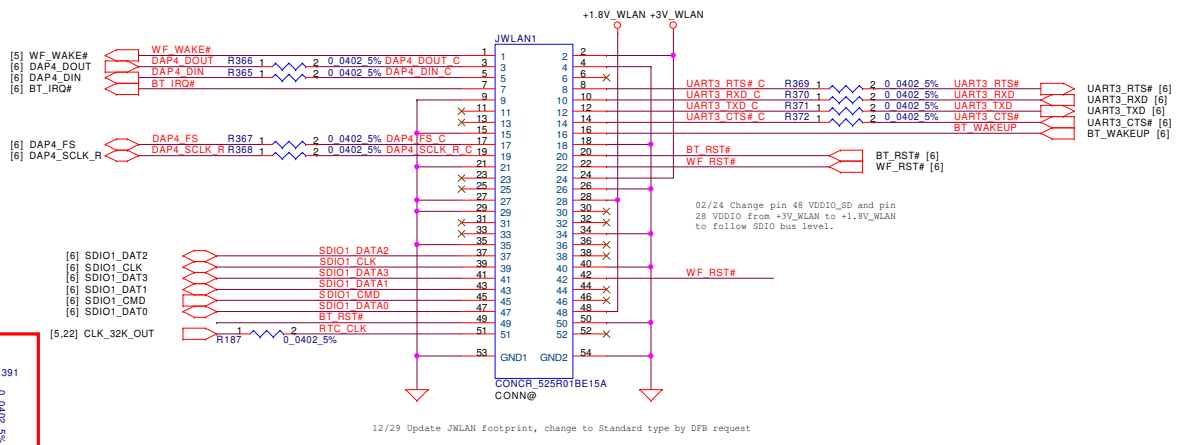


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Issued Date	2011/4/1	Deciphered Date	2010/12/01

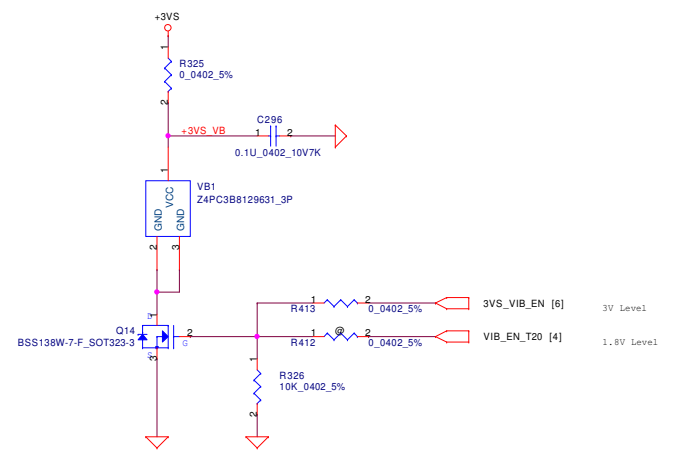
Compal Electronics, Inc.		
CAMERA/LS		
LA-7461P	Rev. 8.3	



WLAN/BT Mini Card

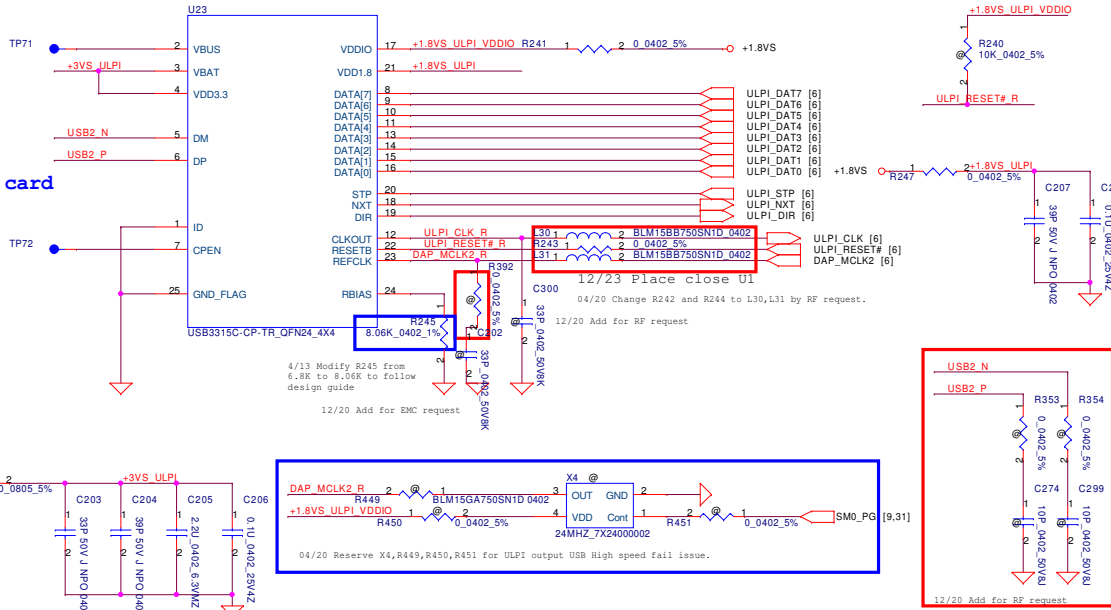


VIBRATOR

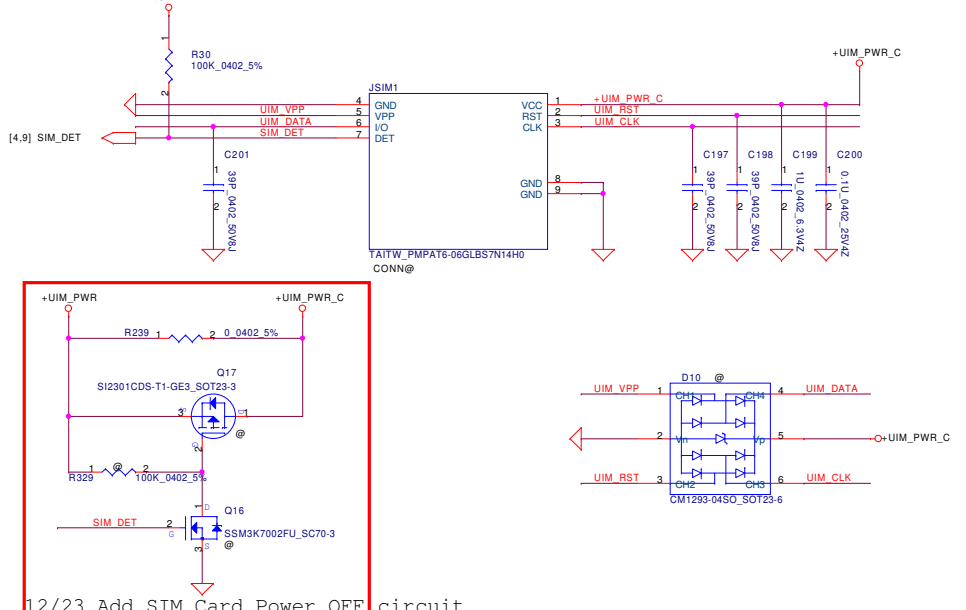


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ULPI

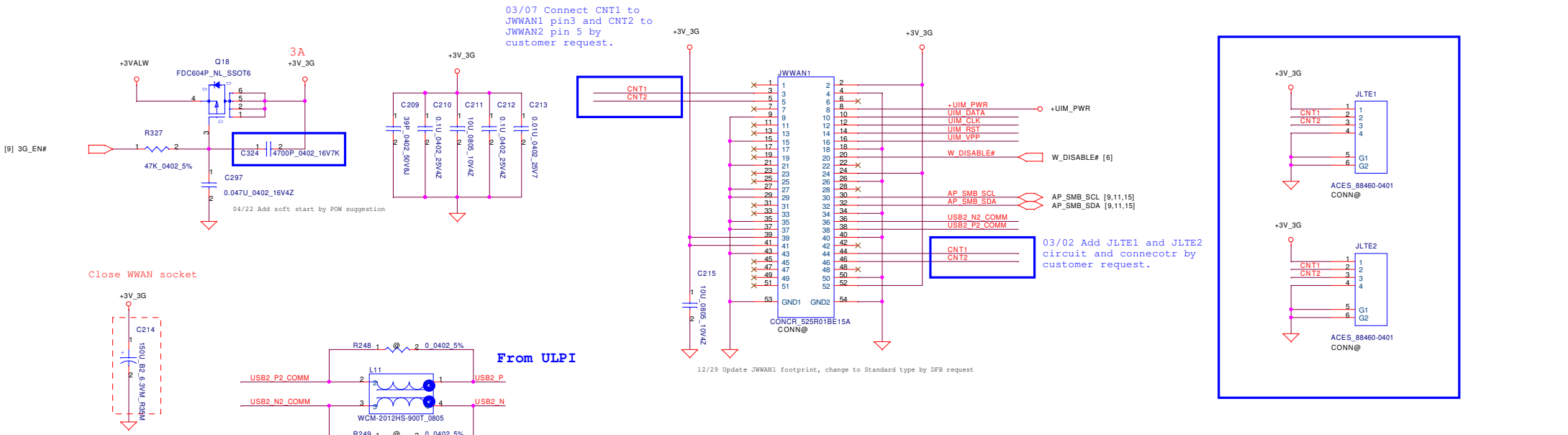


SIM CARD SOCKET



12/23 Add SIM Card Power OFF circuit

Mini-Express Card for WWAN

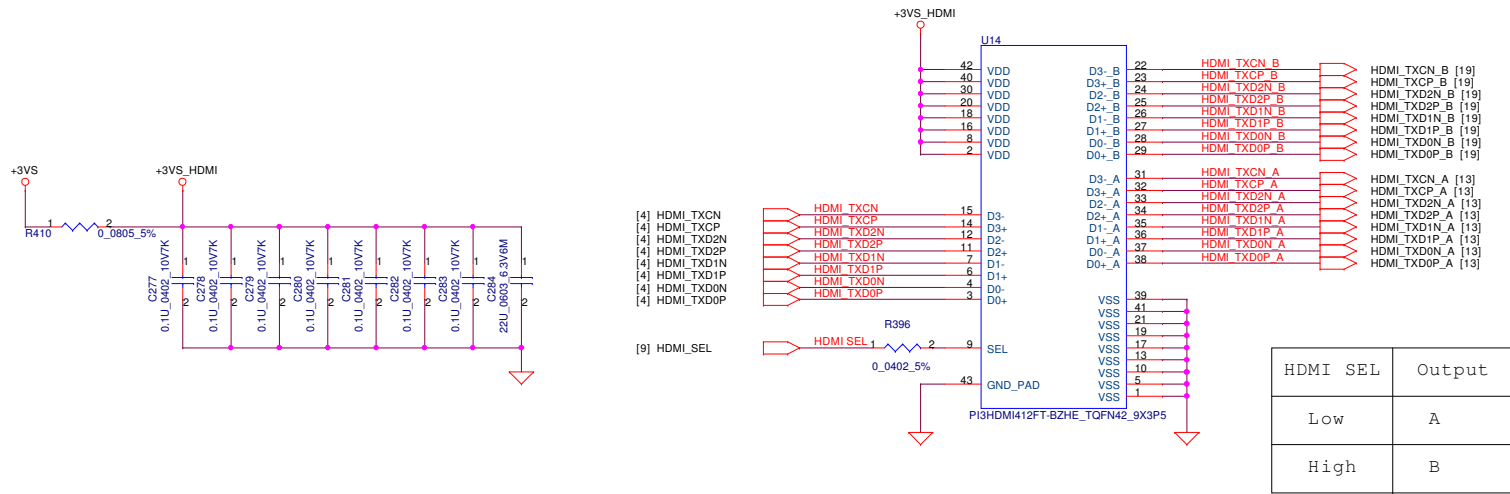


03/07 Connect CNT1 to JWWAN1 pin3 and CNT2 to JWWAN2 pin 5 by customer request.

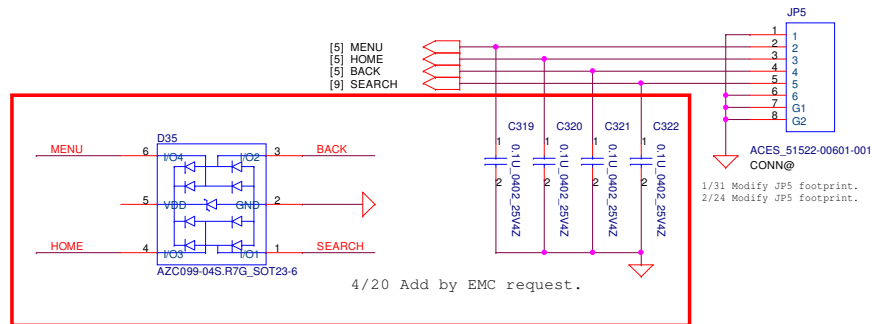
03/02 Add JLTE1 and JLTE2 circuit and connect by customer request.

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HDMI MUX

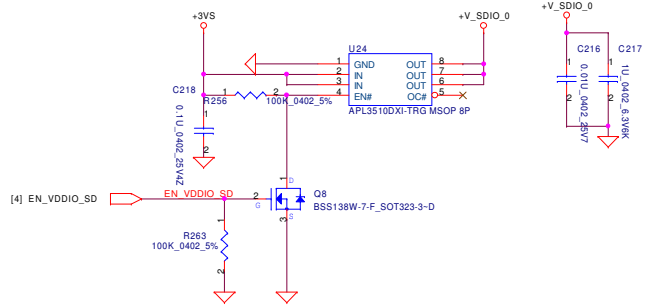


Button Board

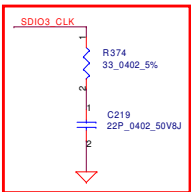
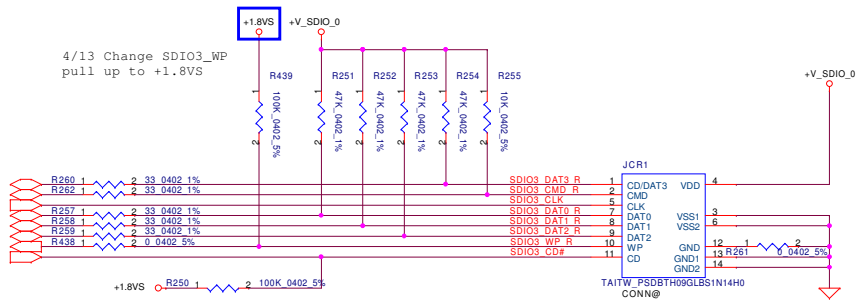


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SD CARD

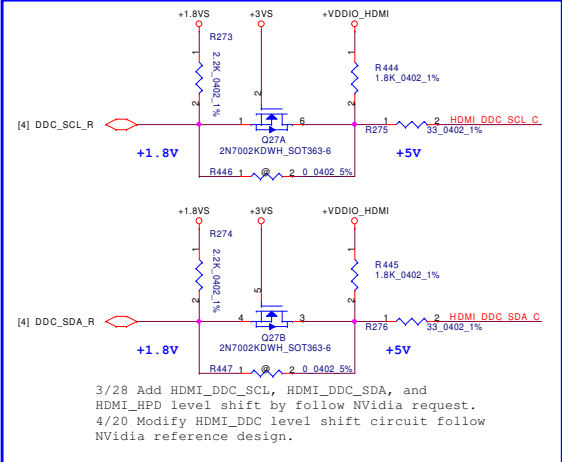
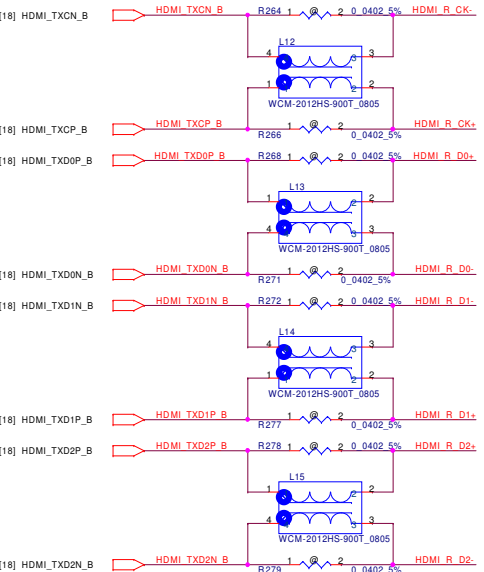


- [6] SDIO3_DAT3
- [6] SDIO3_CMD
- [6] SDIO3_CLK
- [6] SDIO3_DAT0
- [6] SDIO3_DAT1
- [6] SDIO3_DAT2
- [4] SDIO3_WP
- [4] SDIO3_CD#

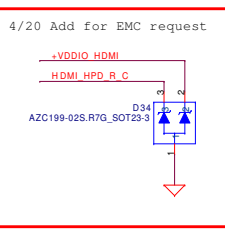
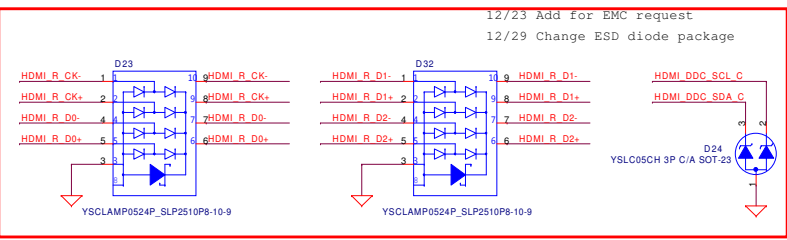


Close JCR1
 12/24 Add by EMC request
 3/28 Mount and change R374 to 33ohms,
 C219 to 22pF by EMI request

HDMI

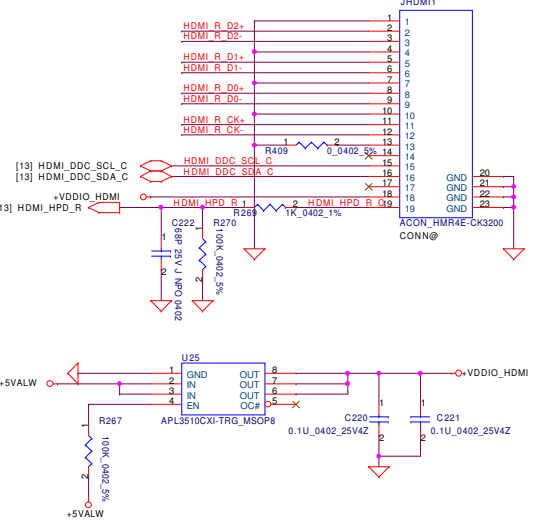


3/28 Add HDMI_DDC_SCL, HDMI_DDC_SDA, and
 HDMI_HPD level shift by follow Nvidia request.
 4/20 Modify HDMI_DDC level shift circuit follow
 Nvidia reference design.



4/20 Add for EMC request
 4/20 Modify HDMI_HPD level shift circuit follow
 Nvidia reference design.

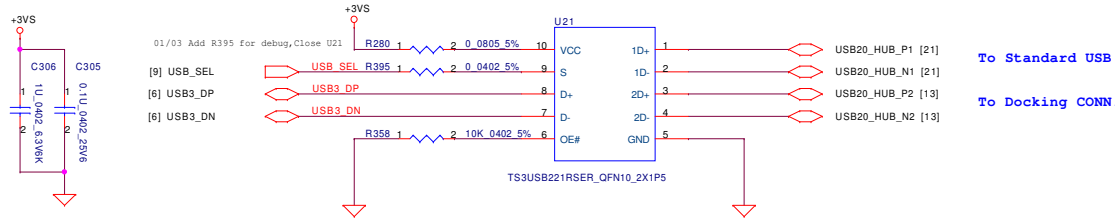
HDMI Type C Connector



• HDMI C Type

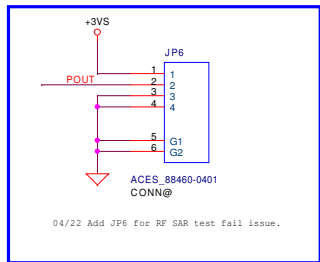
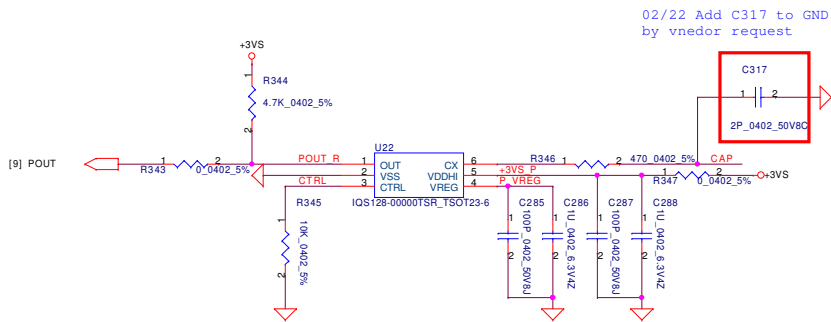
Pin	Pin定義
1	TMDS Data2+ Shield
2	TMDS Data2+
3	TMDS Data1+ Shield
4	TMDS Data1+
5	TMDS Data0+ Shield
6	TMDS Data0+
7	TMDS Data0- Shield
8	TMDS Data0-
9	TMDS Data1- Shield
10	TMDS Data1-
11	TMDS Data2- Shield
12	TMDS Data2-
13	DDC/CEC Ground
14	CEC
15	SC_L
16	SDA
17	Reserved (N.C. on device)
18	+5V Power
19	Hot Plug Detect

USB SW

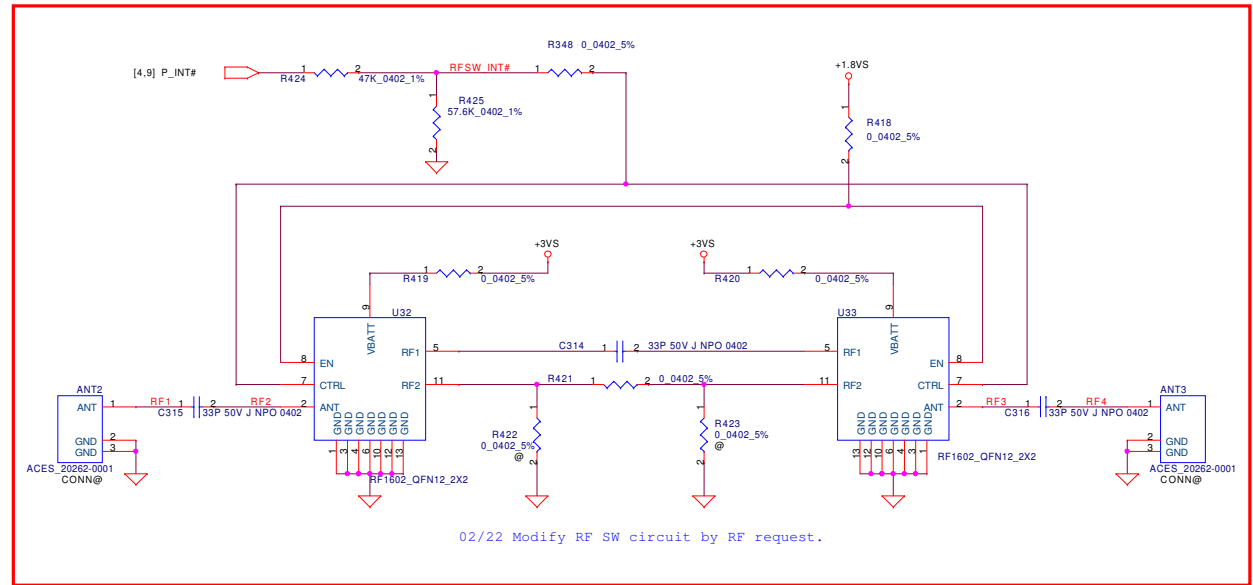


S	Output
L	D = 1D
H	D = 2D

PROXIMITY SENSOR

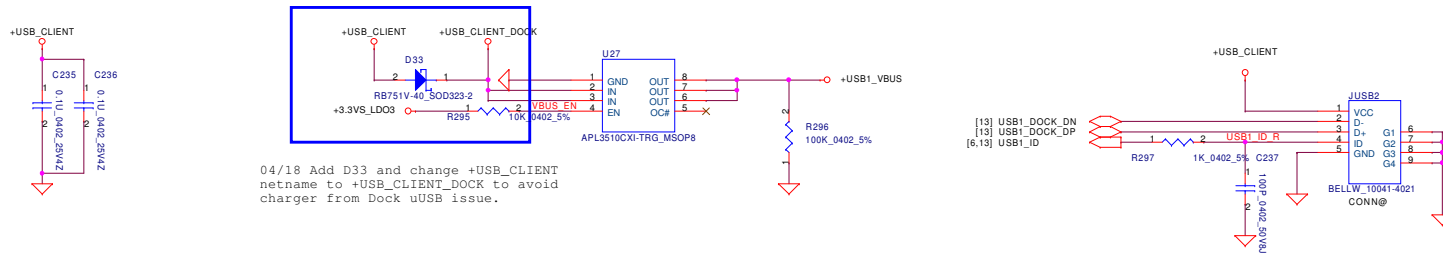


RF SW

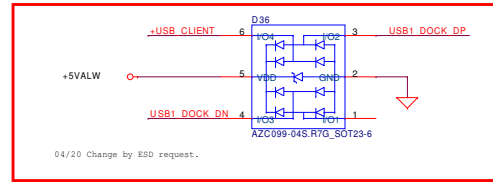


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				USB SW/PROXIMITY/RF SW
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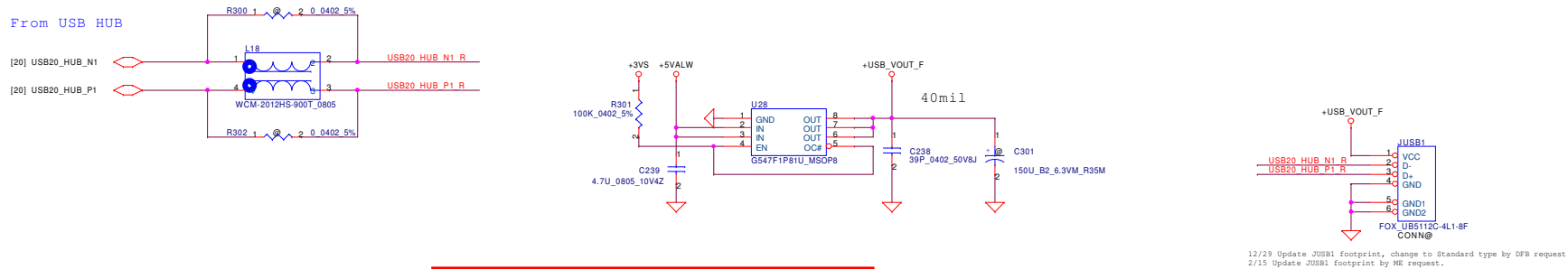
MICRO USB



04/18 Add D33 and change +USB_CLIENT netname to +USB_CLIENT_DOCK to avoid charger from Dock uUSB issue.



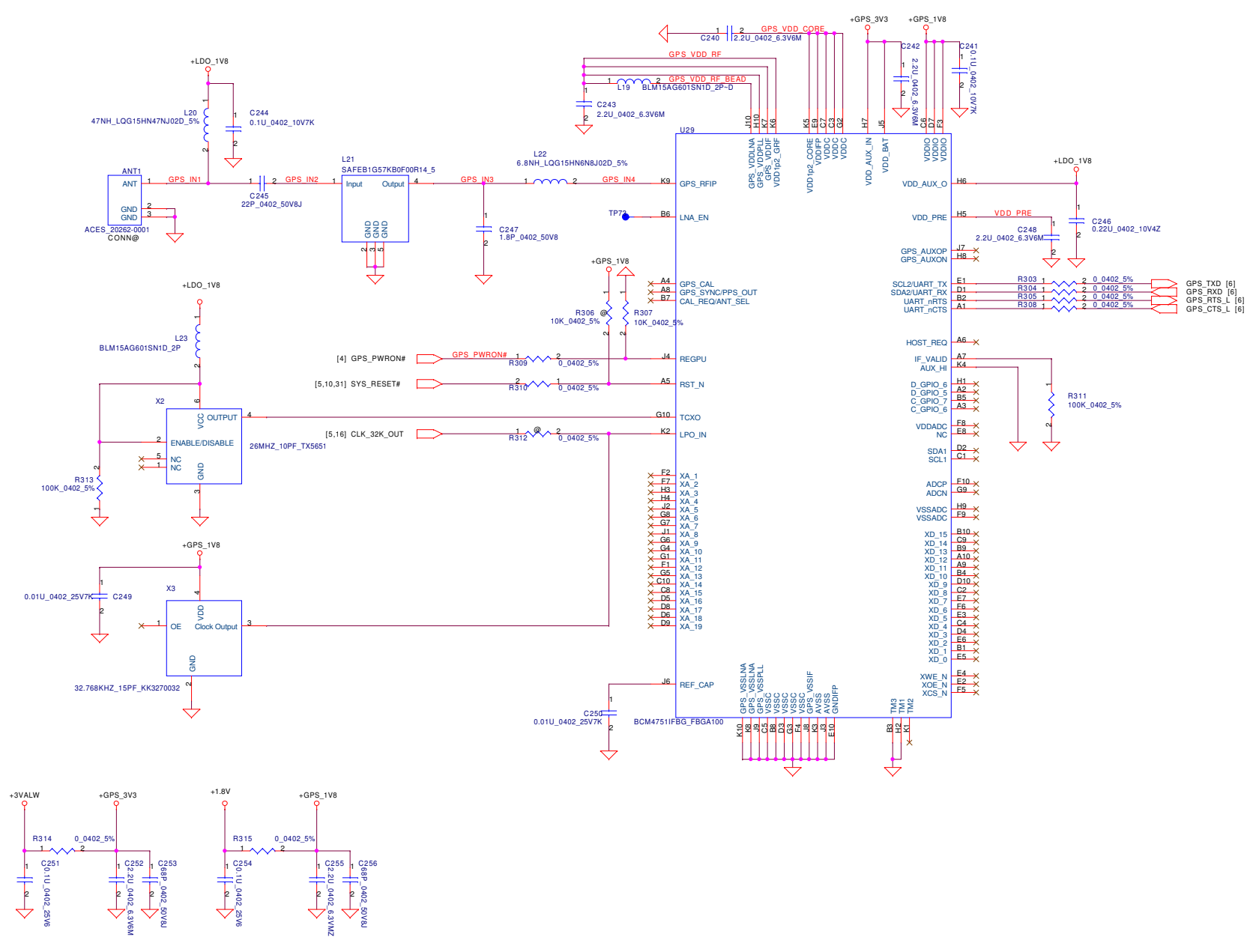
STANDARD USB



04/20 Change by ESD request.

12/29 Update JUSB1 footprint, change to Standard type by DFB request
2/15 Update JUSB1 footprint by ME request.

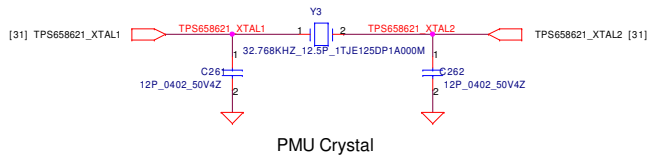
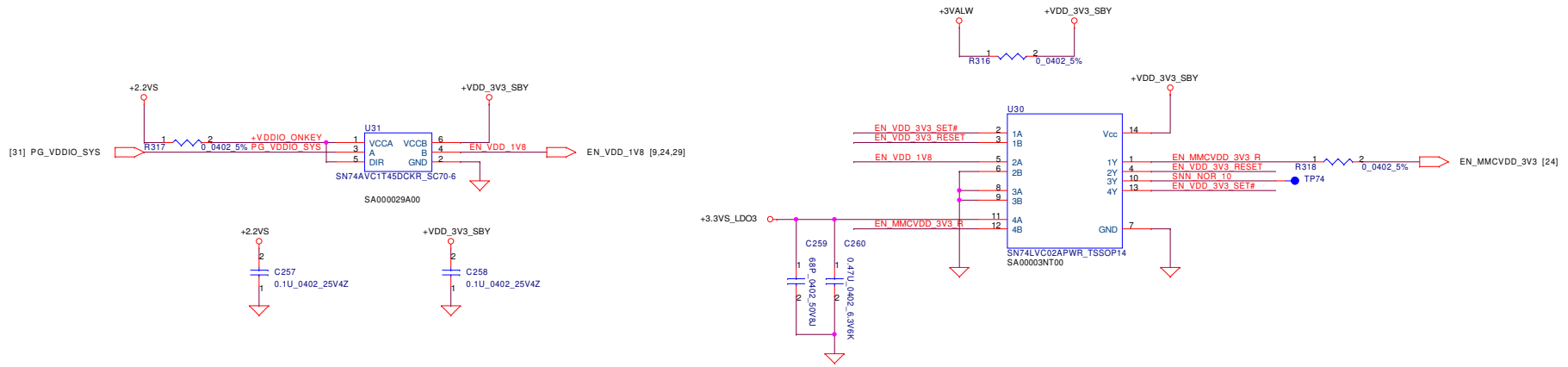
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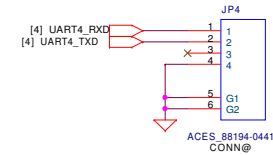
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Size			Document Number	Rev	
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Power Sequence Logic



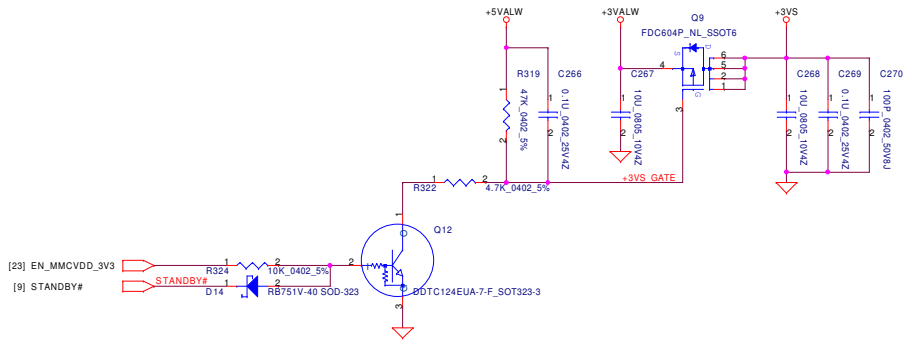
Debug connector



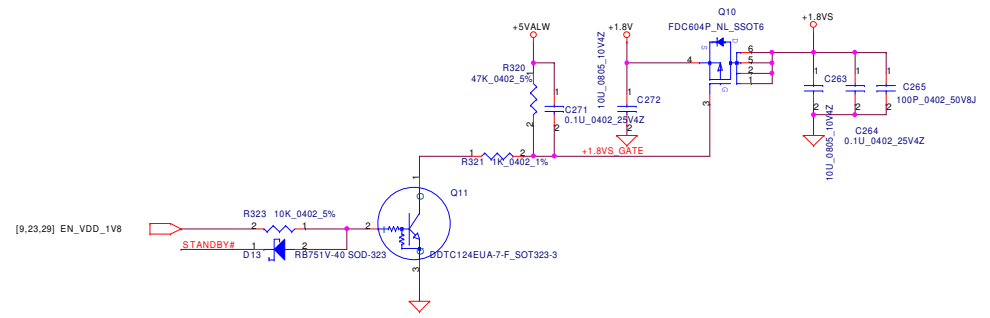
12/16 Add Debug Connector

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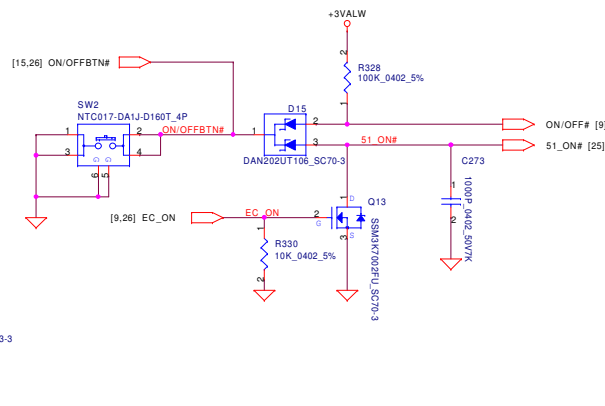
+3VALW to +3VS Transfer



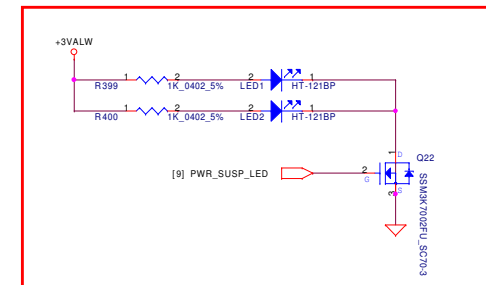
+1.8V to +1.8VS Transfer



Power Button

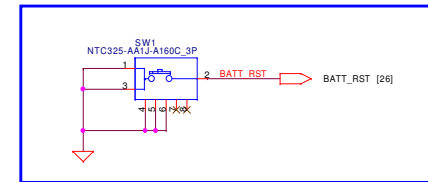


LED

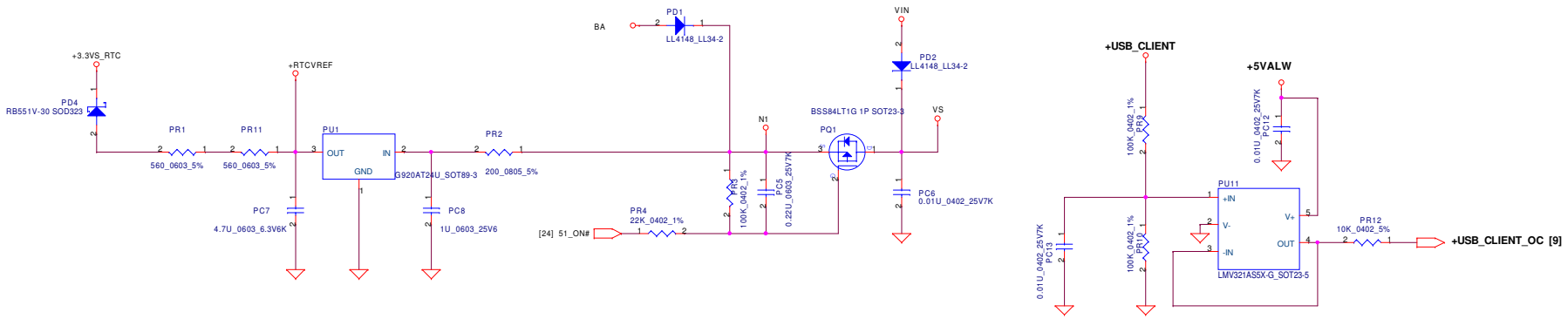
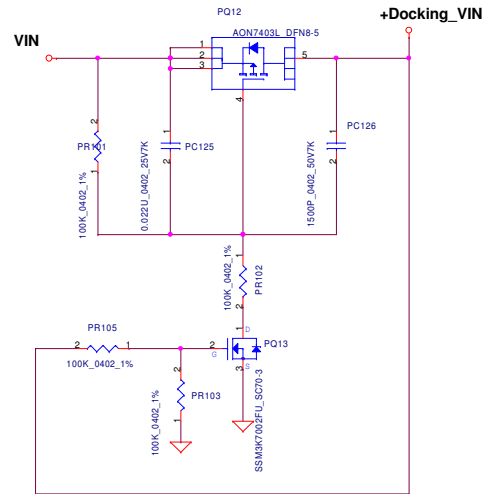
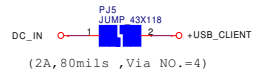
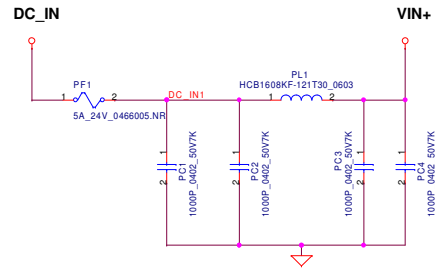


2/9 Add LED for customer request.
4/20 Change LED1 and LED2 from Red light to White light.

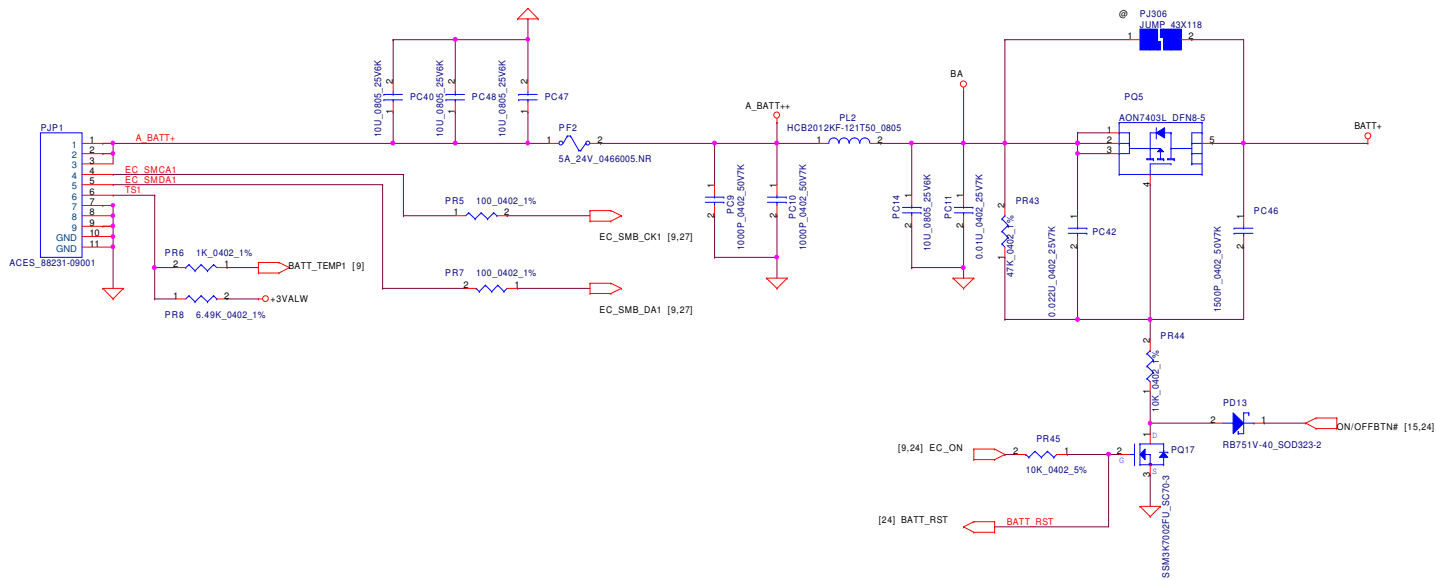
4/15 Move SW1 from PWR side to HW side, since it's HW parts.



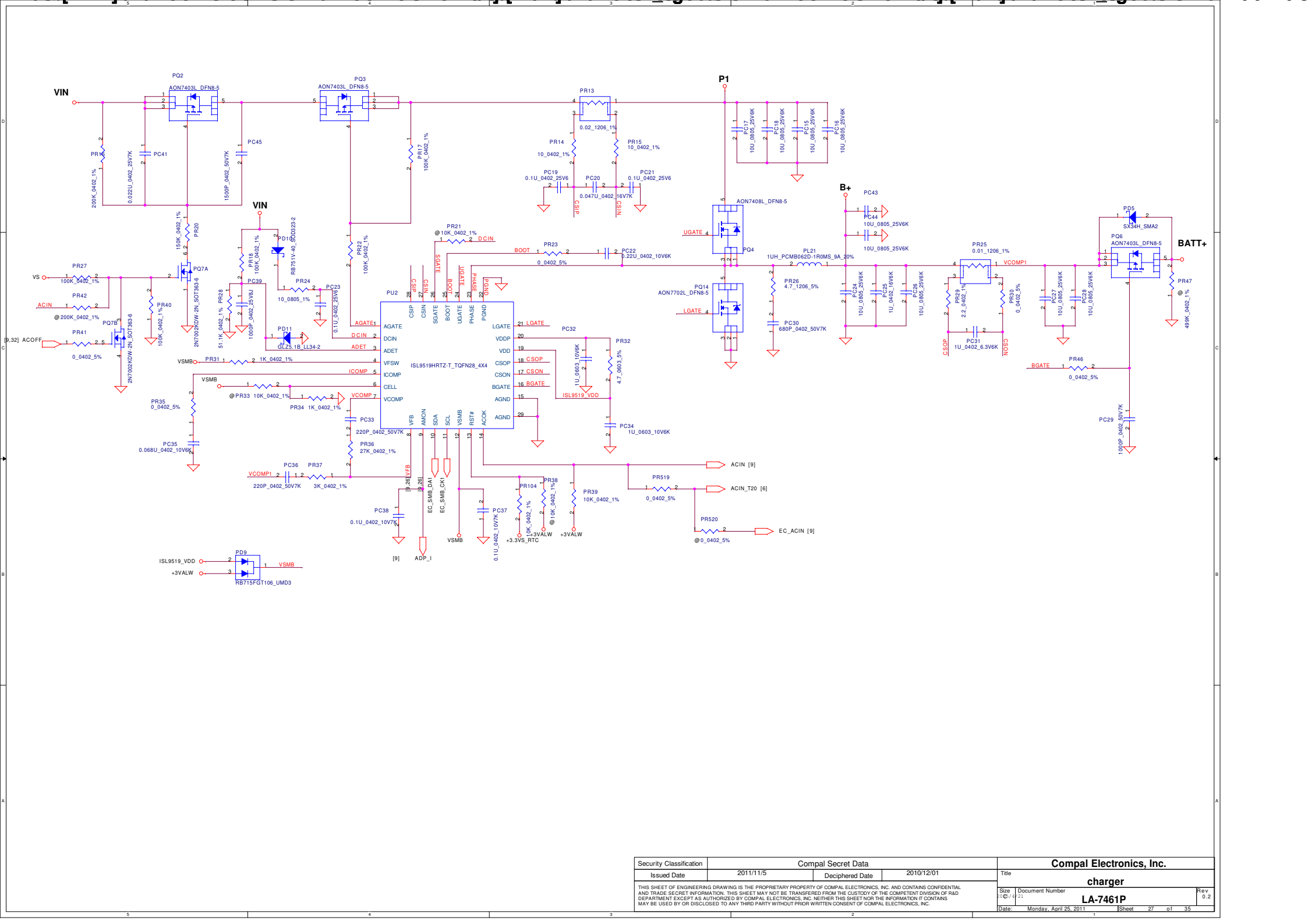
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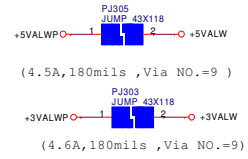
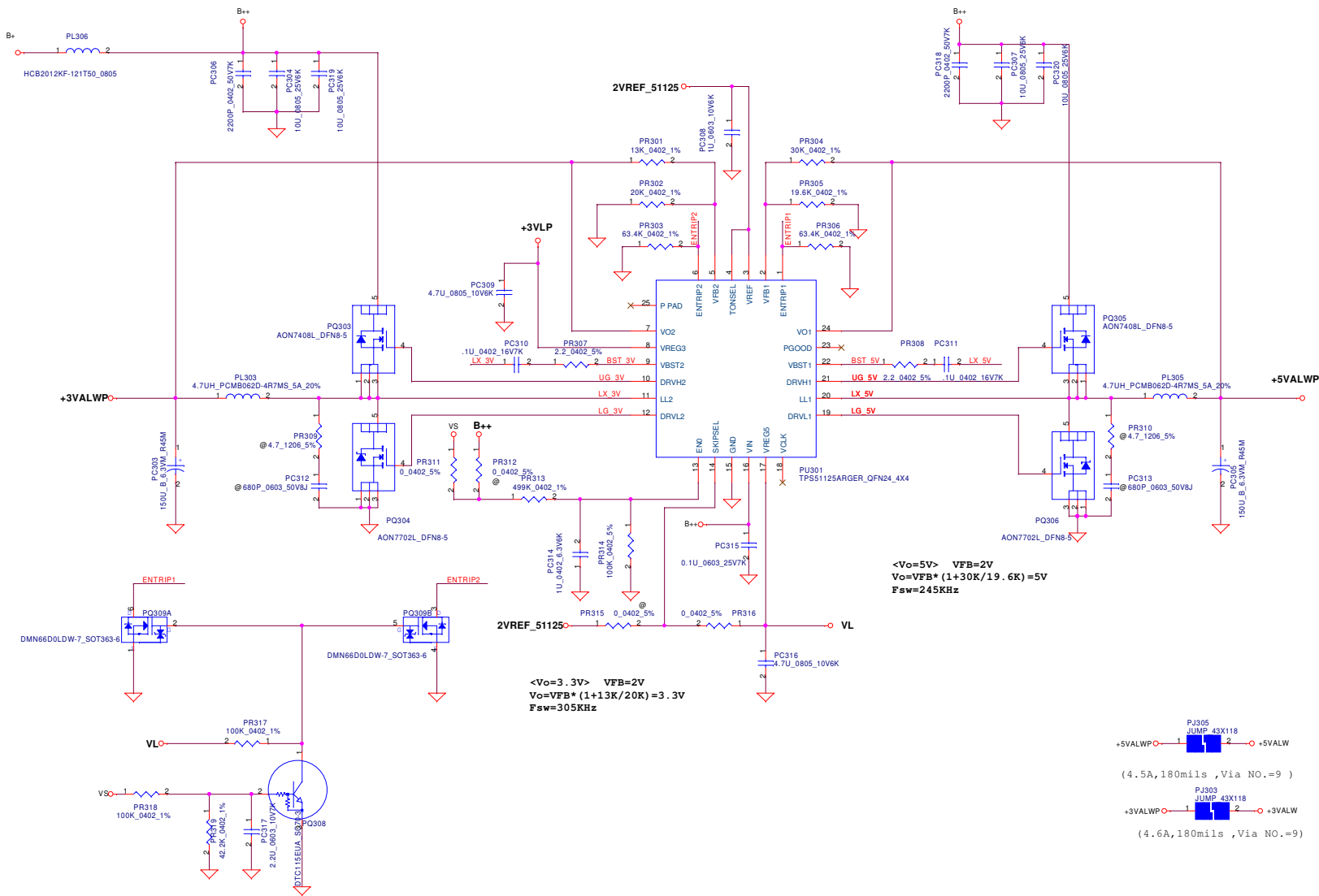
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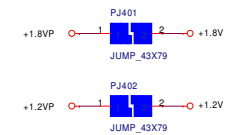
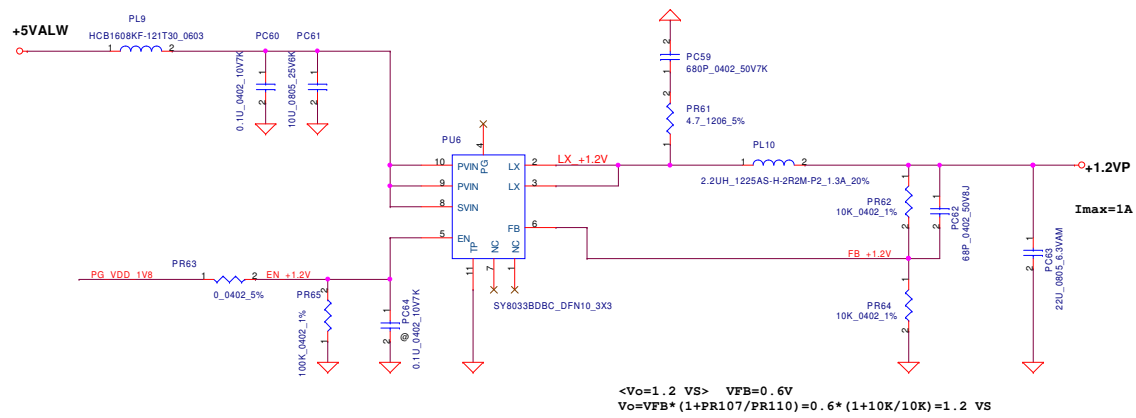
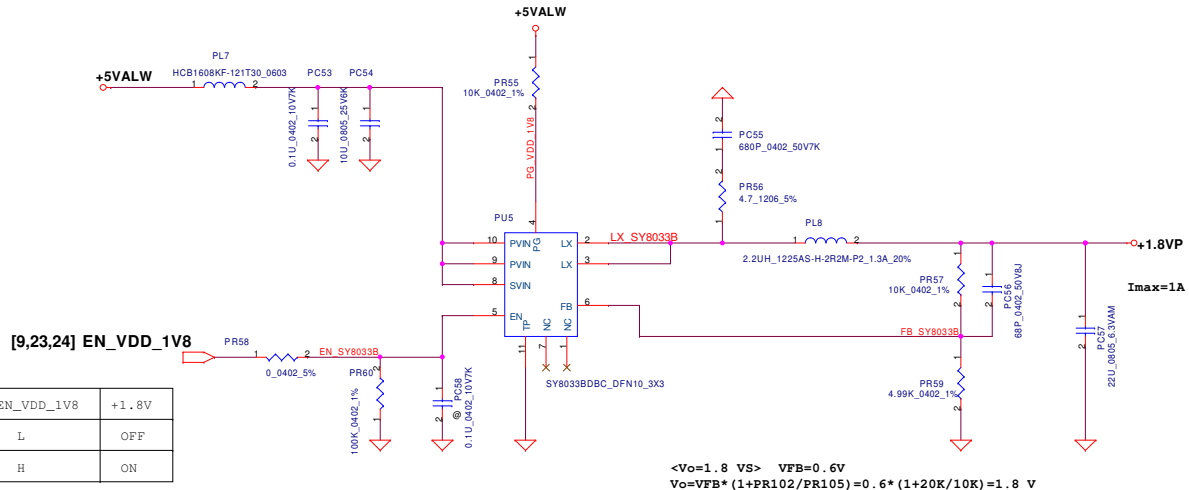
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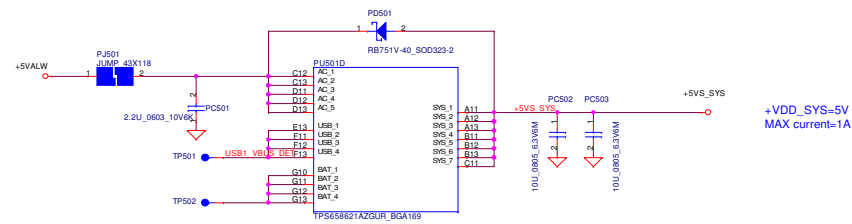


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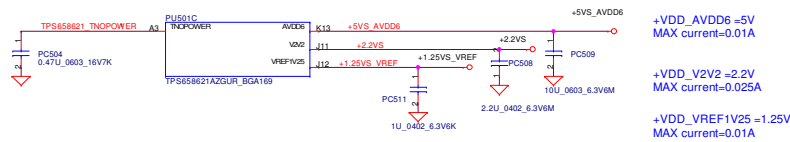
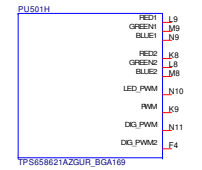


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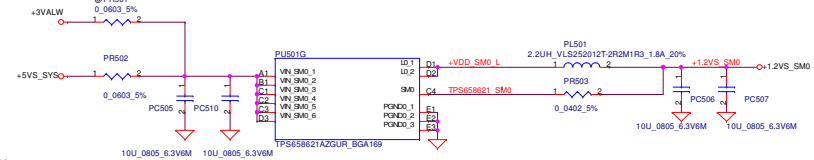
+VDD_SYS=5V
MAX current=1A



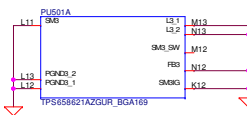
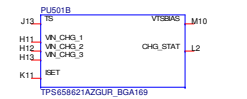
+VDD_AVDD6 = 5V
MAX current=0.01A

+VDD_V2V2 = 2.2V
MAX current=0.025A

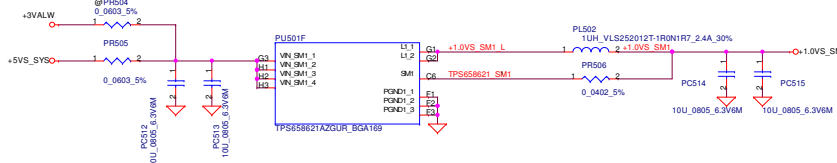
+VDD_VREF1V25 = 1.25V
MAX current=0.01A



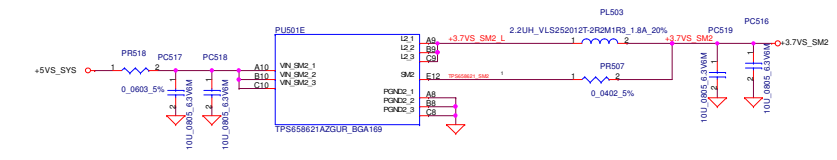
+VDD_SMD=1.2V
MAX current=0.6A



BOOST Converter



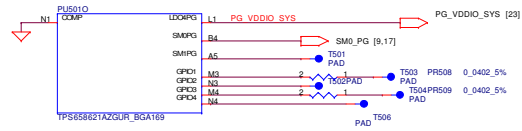
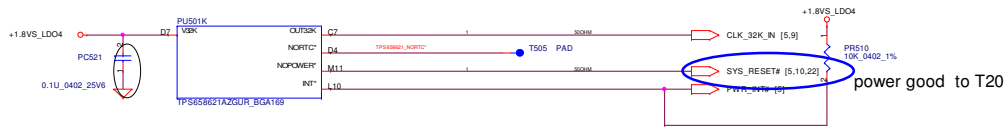
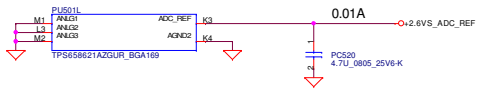
+VDD_SM1=1V
MAX current=1.5A



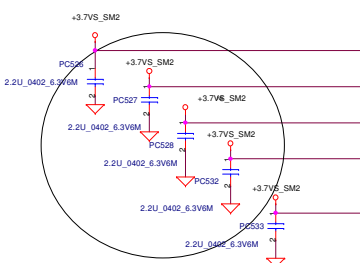
+VDD_SM2=3.7V
MAX current=0.75A

PMU #1

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LAYOUT元件擺出PIN



Version Change List (P. I. R. List) for Power Circuit

<i>Page#</i>	<i>Title</i>	<i>Date</i>	<i>Request Owner</i>	<i>Issue Description</i>	<i>Solution Description</i>
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PHJ00 from SDV to FVT LA-7461P REV:0.1 -> 0.2 Modify <2011.01.30.-2011.03.08. >

Rev.	Item	Date	Impact	Page	Change Cause	Modify Description
0.2	1	1/31	CKT,Layout	7	-DFx suggest modify fiducial mark from two to three for M/B PCB bend test.	-Add FD5 and FD6
0.2	2	1/31	CKT,Layout	9	-Force recovery function always high issue when boot.	-Move SEARCh pin from EC pin 64 to pin 110, and add external pull high R398 to +3VALV.
0.2	3	1/31	CKT,Layout	11	-To solve EN_VDD_PNL turn on issue.	-Add C313 at Q19 G/D side.
0.2	4	1/31	CKT,Layout	12	-Internal SPK noise issue.	-Disconnect CDC_LEFT and CDC_LEFT#, and CDC_LEFT# connect to TP82.
0.2	5	1/31	CKT,Layout	18	-C284 interfere with shielding can.	-Change C284 package from 1206 to 0603.
0.2	6	1/31	CKT,Layout	11,18	-Update connector list from ME request.	-Modify JTS1 and JP5 footprint
0.2	7	1/31	CKT,Layout	7	-ME release newest drawing	-Add H13 and H14
0.2	8	2/9	CKT,Layout	12	-INT MIC can not record	-Delete C153 and C154, and change R191 and R192 to 0 ohms. MIC_LEFT_OUT pull high to +1.8V5, MIC_LEFT_OUT# pull down to AGND.
0.2	9	2/9	CKT,Layout	19	-Update connector list from ME request.	-Modify JCR1 footprint
0.2	10	2/9	CKT,Layout	9,24	-Add RED LED by customer request	-Add R399, R400, LED1, LED2, and Q22.Add SUSP_LED control signal from EC pin 34.
0.2	11	2/10	CKT,Layout	12	-Change HP and LINEOUT CR to GND by vendor request.	-Swap C275 and R193. Swap C276 and R203. Swap C131 and R168. Swap C132 and R169 by vendor request.
0.2	12	2/11	CKT,Layout	16	-BT can not work normally.	-Swap UART3_RXD and UART3_TXD, and swap UART3_RTS# and UART3_CTS# to solver BT cat not work normally.
0.2	13	2/14	CKT,Layout	18	-Power consumption measurement	-Add R410 for power consumption measurement.
0.2	14	2/15	CKT,Layout	13	-Cradle micro USB no function.	-Change JDock pin18 to +USB1_VBUS and serial R411 for solver Cradle micro USB no function issue.
0.2	15	2/15	CKT,Layout	16	-Vibrator can not work normally.	-Add 3V level GPIO 3V5_VIB_EN to control it, and reserve VIB_EN_T20.
0.2	16	2/15	CKT,Layout	11	-Follow sourcer's request to common design.	-Change U9 package from TSOP to BGA type.
0.2	17	2/15	CKT,Layout	11	-TSP pin define modify.	-Modify TSP JTS1 pin define by vendor request.
0.2	18	2/15	CKT,Layout	20	-Power consumption measurement	-Add R414 and R415 for power consumption measurement.
0.2	19	2/22	CKT,Layout	5,9	-Force recovery function abnormal issue	-Add level shift circuit (Q23, R416, and R417) between SEARCh pin and T20
0.2	20	2/22	CKT,Layout	20	-Follow RF's request	-Modify RF SW circuit by RF team request.
0.2	21	2/22	CKT,Layout	20	-Follow vendor's request	-Add 2P capacitance from CAP signal to GND for vnedor request.
0.2	22	2/23	CKT,Layout	11	-TSP SPI bus is 3V level	-Add level shift circuit (U34,U35,R235,R189,R204,C318,R427)
0.2	23	2/24	CKT,Layout	16	-+1.8V5 leakage issue when WiFi enable	-Change pin 48 (VDDIO_SD) and pin 28 (VDDIO) from +3V_WLAN to +1.8V_WLAN.
0.2	24	2/24	CKT,Layout	16	-Follow vendor's request	-Swap DAP4_DOUT and DAP4_DIN signal
0.2	25	3/01	CKT,Layout	10	-Follow DFx's request.	-Add U37 for eMMC 14*18mm footprint by DFx request.
0.2	26	3/01	CKT,Layout	14	-Follow sourcer's request.	-Reserve U36 Thermal sensor.
0.2	27	3/01	CKT,Layout	24	-SW2 interfere with ME.	-Change debug power botton SW2 to Top view type.
0.2	28	3/02	CKT,Layout	6,11	-Follow TSP vendor request.	-Modify TSP level shift circuit and add power switch.
0.2	29	3/02	CKT,Layout		-Power consumption measurement.	-Add R431,R432,R433. Change R104,R122,R121,R143,R144,R158,R159,R160,R161,R179,R220,R221,R223,R230,R231,R232,R233,R246,R410,R280 package to 0805.
0.2	30	3/02	CKT,Layout	17	-Follow customer request.	-Add JLTE1 and JLTE2 circuit by customer request.
0.2	31	3/03	CKT,Layout	9	-Double pull up.	-Delete R319 since SEARCh has double pull resistance.
0.2	32	3/03	CKT,Layout	8	-Modify Net name	-Modify LPDDR2 power net name.
0.2	33	3/03	CKT,Layout	9	-Prevent system hang up issue as PBJ30.	-KBC pin 13 add R436 100K ohms to GND.
0.2	34	3/04	CKT,Layout	12	-Follow vendor request.	-Change HP_AGND and LINE_AGND serial resistance to AGND. Connect HP_AGND to JHP1 pin5.
0.2	35	3/04	CKT,Layout	4,19	-SD Card no write protect function.	-Connect SDIO3_WP from U1 AE12 to JCR1 pin10. Delete R4. Add pull up resistance R439.
0.2	36	3/04	CKT,Layout	11	-Delete TSP debug connector JTS3.	-Delete JTS3 connector since the vendor can provide FFC cable.
0.2	37	3/06	CKT,Layout	13	-Cradle micro USB abnormally.	-Chage JDock1 pin 18 net name from +USB1_VBUS to +USB_CLIENT to solve Cradle micro USB can not work issue.
0.2	38	3/07	CKT,Layout	17	-Follow customer request.	-Add CNT1 to JWWAN1.3 and CNT2 to JWWAN1.5 for LTE function.
0.2	39	3/07	CKT,Layout	15	-Camera I2C bus level is 3.3V.	-Add CAM_I2C bus level shift circuit (Q26 - R440 - R441) to 3V level.
0.2	40	3/08	CKT,Layout	11	-Follow RF request	-Change C147,C148,C150,C152,C195,C196,C302,C303 from 10pF to 18pF by RF request.

PHJ00 from FVT to SIT LA-7461P REV:0.2 -> 0.3 Modify <2011.03.22.-2011.04.22. >

Rev.	Item	Date	Impact	Page	Change Cause	Modify Description
0.3	1	3/23	CKT,Layout	11	-Modify JTS1 pin define by follow vendor request.	-Swap JTS1 pin2 and pin3 to follow module pin define.
0.3	2	3/28	CKT,Layout	11	-C298 Material shortage	-Change C298 package from 0603 to 0805
0.3	3	3/28	CKT,Layout	13,19	-Follow NVidia request	-Add HDMI_DDC and HDMI_HPD level shift circuit (Q27 - Q28 - R444 - R445 - R446 - R447). Modify JDock1 pin 30 and 31 net name.
0.3	4	3/28	CKT	19	-Follow EMI request	-Change and instal R374 to 33ohms and C219 to 22pF by EMI request.
0.3	5	3/28	CKT	9	-X1 output CLK not accurate enough.	-Change C99 and C100 to 33pF by vendor suggestion.
0.3	6	4/13	CKT	17	-Follow SMSC USB3315 reference design	-Change R245 to 8.06K 1%
0.3	7	4/15	CKT	12	-SPK voice too small	-Change C149 to 3900pF by Audio team request.
0.3	8	4/13	CKT,Layout	19	-Avoid leakage issue.	-Change SDIO3_WP pull up level to +1.8V5
0.3	9	4/15	CKT	24	-BOM issue	-Move SW1 from PWR side to HW side.
0.3	10	4/15	CKT,Layout	9	-Power charger unstable issue.	-Add EC_ACIN by power and EC request.
0.3	11	4/15	CKT,Layout	6	-Power charger unstable issue.	-Change ACIN netname to ACIN_T20 by power request.
0.3	12	4/18	CKT,Layout	13,21	-Charger from Cradle micro USB issue.	-Add D33 and change +USB_CLIENT netname to +USB_CLIENT_DOCK to avoid charger from Cradle micro USB issue.
0.3	13	4/20	CKT,Layout	19	-Follow EMC request.	-Add ESD diode D34 for EMC request.
0.3	14	4/20	CKT,Layout	18	-Follow EMC request.	-Add C319,C320,C321,C322, and D35 by EMC request.
0.3	15	4/20	CKT,Layout	21	-Follow EMC request.	-Change D11,D12 to D36,D37 by EMC request.
0.3	16	4/20	CKT,Layout	14	-AKM eCompass shortage issue.	-Reserve Yamaha eCompass U38 by AKM eCompass shortage issue.
0.3	17	4/20	CKT,Layout	13	-Follow EMC request.	-Remove R341,R342, and install L29 by EMC request.
0.3	18	4/20	CKT	17	-Follow RF request.	-Change R242 and R244 to L30,L31 by RF request.
0.3	19	4/20	CKT	24	-Change LED1 and LED2 from Red light to White light	-Change LED1 and LED2 from Red light to White light
0.3	20	4/21	CKT,Layout	12	-Follow EMC request.	-Add C323 and connector HP_AGND to D4
0.3	21	4/21	CKT,Layout	13	-Follow EMC request.	-Del ESD diode D6,D19,D20,D21,D22,D25,D31
0.3	22	4/20	CKT,Layout	17	-For ULPI PHY high speed test fail issue.	-Reserver X4,R449,R450,R451
0.3	23	4/20	CKT,Layout	13	-Follow EMC request.	-Modify JDock1.6 and JDock1.7 netname
0.3	24	4/20	CKT,Layout	19	-Follow NVidia reference design.	-Modify HDMI_DDC and HDMI_HPD level shift circuit. Change R444 and R445 to 1.8K. Change R273 and R274 to 2.2K. Add R448 HDMI_HPD pull down resistance.
0.3	25	4/20	CKT,Layout	21	-Follow EMC request.	-Change D36 and D37 to AZC099 by EMC request.

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PHJ00 from FVT to SIT LA-7461P REV:0.2 -> 0.3 Modify <2011.03.22.-2011.04.25. >

Rev.	Item	Date	Impact	Page	Change Cause	Modify Description
0.3	26	4/22	CKT,Layout	5	-For without 3G SKU setting	-Add R452 pull down for SW 3G SKU detect.
0.3	27	4/22	CKT	8	-Customer request.	-Change R93,R94,R95,R96 to 12K_1%
0.3	28	4/22	CKT,Layout	15	-Vendor request.	-Reserver C325 for vendor request.
0.3	29	4/22	CKT,Layout	17	-Reduce power on irush current.	-Add soft start C324 to reduce irush current
0.3	30	4/22	CKT,Layout	20	-Follow FR request.	-Add JP6 by RF request for SAR test.
0.3	31	4/22	CKT,Layout	12	-INT MIC noise issue.	-Add R435,C326 to reduce Int. MIC noise issue.

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